

Mapping 21st century Science/Technology linkages: has science become more important in recent technological development?



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Working paper

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EXECUTIVE SUMMARY

Productivity slowdown, innovation and science

What is causing the long-term slowdown in productivity growth in recent decades? Are there insufficient technological or organisational innovations that lead to new products and services for global markets? Is the further development of emerging technologies hampered? Is there a lack of novel 'breakthrough' discoveries in science that may lead to innovations? Or is it because of other factors or determinants that impact on advances in innovation? Economic experts point at innovation-related knowledge diffusion processes is one of the possible explanations. But details on causal relationships are unclear.

More empirical data are sorely needed to unravel the linkages and knowledge flows between science, technology and innovation. Hence, one of the topics of rising interest in contemporary science and innovation policy is the role of basic and applied scientific research as a driving force of new emerging technologies and related technological innovations. This empirical study is meant to help clarify contributions of science to advanced technological development, by addressing the question: is discovery-oriented science becoming increasingly important in recent developments of emerging technologies?

Analysing knowledge flows between science and technology

The data analysis methodology derives its information from observed linkages between patents and scientific research publications. The main advantage of this empirical approach is the availability of comprehensive, long-term and internationally comparable data. This enables large-scale, systematic measurement of linkages and knowledge flows between (discovery-oriented) science and (patented) technology (S/T linkages). Part of these links represent genuine knowledge flows, part reflect other types of connections.

As for the statistical data, the S/T linkage table comprises of pairwise citation frequency counts. The S/T pairs are defined by the citing patents, that explicitly mention scientific research in their list of referenced sources, and the cited research publications. Because of time-lags involved between knowledge creation and knowledge utilization in technological development, the numbers of these S/T citation linkages will inevitably go down as one moves to the current date. Many results of science that will shape the future generation of technologies are yet to be published.

The citation-based S/T linkage analysis in this report was done at the aggregatelevel of entire scientific disciplines to technology areas. The trend analysis of changes in the S/T linkage tables compares three consecutive time-periods: 2000-2004, 2005-2009 and 2010-2014. Given the time-lagged nature of S/T data, the above key question cannot be addressed directly and unambiguously. Instead, a series of derivative research questions have been addressed that provide partial answers:

- which technology areas exhibit high-growth rates in terms of S/T linkages? This trend analysis compares: 2005-2009 vs 2000-2004 and 2010-2014 vs 2005-2009.
- are there processes of S/T strengthening, where some scientific disciplines are becoming increasingly important, or intertwined, with technological development? This trend analysis compares: 2005-2009 and 2010-2014.
- which technology areas exhibit processes of S/T broadening or S/T narrowing, where an increasing or decreasing diversity of scientific disciplines are becoming major contributors of technological development? And what are the details in the case of 'Artificial Intelligence technology'.

Generating an overview of general patterns and trends, the macro-level citation data were analysed for two geographical areas: (1) OECD area, covering the club of world's most advanced economies; (2) European Union (EU28) area, representing the European continent. The findings are compared to identify significant differences between Europe and globally.

Science/Technology links: patterns and trends in the OECD area

- Four technology areas exhibit domains where S/T linkages have increased rapidly between 2000-2004 to 2005-2009: 'Nanotechnology'; 'Imaging and sound technology imaging technique'; 'Imaging and sound technology sound technique'; 'Large-capacity and high speed storage'. In the majority of the fast-growth scientific disciplines are either 'Energy science and technology', or 'Environmental sciences and technology'. Both disciplines seem to have strengthened their contribution to 'Nanotechnology' between 2000-2004 and 2005-2009. Very few other domains are found where S/T strengthening occurred.
- The number of disciplines involved in S/T broadening processes has increased. These where found mainly in the medical/health/life sciences domains, whereas S/T narrowing tended to occur in natural sciences, engineering sciences and computer science.
- The technology area of 'Security Electronic payment' is interesting. It shows significant changes between 2005-2009 and 2010-2014, where 'Agriculture and food science' increased its share of S/T links from 2% to 6%, 'Basic life sciences'(from 2% to 6%) and chemistry and chemical engineering (from 3% to 7%). The two largest scientific disciplines of this technology area remain the

same: 'Computer science' (28% in 2010-2014) and 'Electronic and electrical engineering' (21%).

- As for S/T narrowing, here we find several disciplines in decline as major contributor: 'Biomedical sciences'; 'Electrical engineering and telecommunications'; 'Mechanical engineering and aerospace'; and 'Physics and materials science'. The latter two disciplines have lost further ground since 2011.
- 'Nanotechnology' is one of the dominant technology areas that have become more science-based during the last 15 years.
- The technology area of Artificial Intelligence ('AI technology') is marked by large differences between the contributions of disciplines as well as some significant changes over time. The no 1 'enabler' discipline in this area, 'Computer science', has lost ground as a major contributor in favour of 'Chemistry and chemical engineering', 'Biological sciences', and 'Agriculture and food science'. Overall, we observe a gradual shift towards more contributions from chemistry and the life sciences.
- The area covering the Internet of Things ('IoT and related technologies') shows a strong concentration of contributions from Electronic and electrical engineering and from Computer science. Together they account for 90% of the S/T links. The share of 'Electronic and electrical engineering' has increased, while 'Computer science' decreased.

Science/Technology links: patterns and trends in the EU28 area

- Analysing the changes between 2000-2004 and 2005-2009, no less than 25 technology areas contain at least one fast-growth scientific discipline. Three technology areas are prominent in that respect: 'Industrial biotechnology'; 'Advanced materials'; 'Pharmaceuticals'.
- Very few cases are found of S/T strengthening. Overall, the EU28 profile is quite different from the OECD findings. The main similarity between both geographical areas is the significant emergence of 'Energy science and technology' throughout those 15 years, and the rise of 'Environmental sciences and technology' in more recent years. The findings reveal continued strengthening of the links between the technology area 'Macromolecular chemistry, polymer' and the discipline 'Energy science and technology', as well as between 'Industrial biotechnology' and 'Energy science and technology'.
- Three technology areas show signs of S/T broadening, one of which is also on the OECD list: 'Large-capacity information analysis data analysis simulation management'. In contrast, 'Nanotechnology', irrespective of how this area is delineated, is S/T narrowing; the same pattern occurs in the OECD area.

- As for the case study of 'Artificial Intelligence', again the data show a gradual decline of 'Computer science', and the rise of 'Chemistry and chemical engineering' and 'Energy science and technology'. However, several new EU28specific features emerge: the rise of 'Physics and materials science'; the decline of 'Biomedical sciences' and 'Clinical medicine', the rise of 'Instruments and instrumentation'.
- The EU28's S/T profile in Internet of Things ('IoT and related technologies') is similarly to the OECD's profile, but with a smaller number of disciplines with a significant low-level contribution.

Moving towards answers

- This macro-level exploratory study provides indications of 'structural' changes in knowledge flows between scientific fields and some technology areas, where disciplinary composition of contributing science is changing; key 'enabling' fields are becoming less important, while other fields are on the rise.
- Changes seem depend in part on geography-related determinants or geopolitical factors. The many observed (small and large) differences when comparing 'OECD area' and the 'EU area' provide empirical evidence to this effect.
- The EU28 profile is quite different from the OECD findings, which requires further studies. Such studies should also be broken down at the level of separate countries (by patent applicant) provided the number of patents is sufficiently large to enable robust and reliable analysis.
- Some findings may also relate to possible biases in the information sources. Especially with regards to the patents, which are affected by changes in patenting policies and/or practices of national patent offices. Follow-up studies should distinguish the effects of new or changing patent legislation or IPR practices, or modifications in patent classification systems, from actual changes in technological development and the nature of S/T relationships.
- Concluding, this data-rich analytical approach describes macro-level patterns and trends that may help assess the 21st century evolution we are witnessing in S/T interactions and linkages.
- However the observed changes in S/T linkage patterns are gradual and extremely difficult to interpret unambiguously. It is impossible to determine whether or not contemporary science, as a whole, has become more important for technological development.
- The citation links between research publications and patents provide an information source for in-depth case studies that may help unravel and contextualize the macro-level findings described in this exploratory study.

 More work is needed to gain insights in processes. Innovation analysts should dig deeper to understand the specifics of how advances in science impact on technology, and how science-based technology may result in the new generations of innovative products and services. We need to move from the 'what & where' to the 'how & who' questions regarding economic productivity and the role of science and technology.

1 Introduction

Productivity is expected to be the main driver of economic growth and well-being over the next 50 years, in part via investment in knowledge-based capital and technological innovation. However, findings of recent analyses suggest that innovation-related diffusion processes seem to have slowed down in several advanced economies, hampering their ability to support stronger productivity growth (OECD, 2015a). The slowdown in productivity over the past decade has added to concerns about long-term economic outlook. Understanding how progress in science is connected to technological development is crucial to get a better handle of the drivers and policy levers that can foster science-based innovation in a rapidly changing innovation ecosystems and knowledge-intensive economies.

One area of rising interest is understanding in more detail the role of basic and applied scientific research in driving new emerging technologies and related technological innovations. Science is an important source of novel ideas, tools, materials and prototypes in some areas of advanced technological development. The key question however is whether or not science has become increasingly important in recent technological developments. To address this question, in a broad systematic fashion, one needs to establish a stable frame of reference, appropriate empirical information, and a sufficiently long time-window.

The data analysis methodology is based on observed linkages between patents ('technology') and scientific research publications covered in bibliographic databases (discovery-oriented 'basic science'). The main advantage is availability of comprehensive, long-term and internationally comparable data (OECD, 2016). The next section presents more details on this methodological approach and its data sources.

2 Analytical approach

2.1 Science/Technology linkage data

The large majority of the patents worldwide are filed by business enterprises (a small minority are patents by public sector organisations such as universities).¹ Especially in the case of the R&D-intensive industries, one finds large quantities of patents that mention scientific and technical research literature in their 'prior art' reference lists. These literature references (or 'citations' as they are usually named) reflect the usage or 'impact' of science on technological development. These 'patent-to-publication citations' ('patent citations' for short) represent an explicit link between patented technical inventions ('technology') and published scientific and engineering research ('science'). Depending on the type of technology, a significant share of those citations include research articles in international scientific journals ('research publications').²

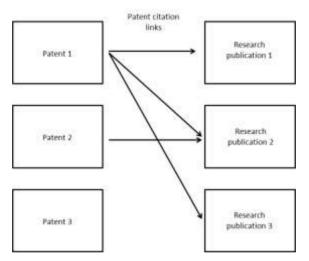


Figure 1a. Micro-level S/T linkages: patents and research publications

Figure 1a presents a graph of such citation patterns at the micro-level of individual patents and research publications, where the 'science-based' patent 1 cites several scientific research publications (within a specific period of time) while patent 3 has no explicit citation links to any of these three research publications. This illustrative,

¹ The country of the patent filing business enterprise is not necessarily the same country where the technology was developed or corporate R&D was conducted - especially in the case of large multinationals where patent filing is often centralised in the country of the corporate (R&D) headquarters.

² Where each 'citing' patent is assigned to one or more 'technology areas', according to the International Patent Classification (IPC) codes, each 'cited' publication can be classified it its respective 'scientific discipline'. To the extent that such citations are sufficiently numerous, the S/T linkage table allows for a systematic, quantitative assessment of the relationship between the 'citing' technological areas and 'cited' scientific disciplines. The majority of the citing patents relate to two 'science-based' technology domains: computing/electronics and pharmaceuticals/biotechnology. Obviously, these disciplines are skewed towards those fields of science with strong links to these technology areas.

stylized example is limited to 3 documents on both sides. The reality there are millions of patents that cite one or more research publications.

These citation-based S/T linkages can be aggregated on either side of the S/T divide. Figure 1b exhibits the meso-level of patent domains (usually delineated in terms of International Patent Classification system codes assigned to a patent) and research domains (each delineated in terms of a set of scientific journals consisting of research publications). Patent domain 2 cites three domains but its strongest citation linkages are with research domain 2. Again, some patent 'science-extensive' domains may have no citations to research domains – see patent domain 3. Note that both selected types of delineation are one of several possible options to define domains.

The domains were further aggregated to the macro-level of 'technology area' and 'scientific discipline' (see Graph 1c). The terminology and associated delineations were decided in consultation with the EC and OECD. Here we find strong links between technology area 1 (say, Pharmaceuticals) and scientific discipline 1 (say, biomedical sciences). Technology area 3 cites some disciplines, but at relatively low levels. Also at this high level, some technology areas will include patents that do not cite research publications in specific scientific disciplines. The citation links can also be interpreted from the science side, where scientific discipline 2 has the broadest range of S/T links, covering three technology areas. Scientific discipline 1 is only cited by one area.

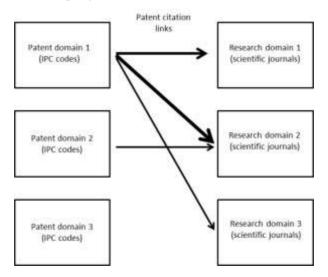
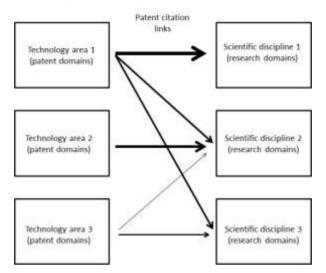


Figure 1b. Meso-level S/T linkages: patent domains and research domains

Figure 1c. Macro-level S/T linkages: technology areas and scientific disciplines



The S/T linkage data-analysis in this report will be at the macro-level, in the analytical tradition of many other studies of this kind that have been conducted during the last two decades.

Using the patent citations and citation frequency counts as an analytical lens, the results of various macro-level cases studies seem to imply that contributions of basic science in supporting the development of industrial innovations has been increasing – at least in volume – over the past two decades (see for example: Narin et al. 1997; Tijssen et al., 2000; Callaert et al., 2012; Ahmadpoor & Jones, 2017; Ranaei et al., 2017; Wang & Li 2018; Jefferson et al., 2018). However, inevitably patent-based analysis can only provide a 'blurred and partial' lens on the nature and intensity of S/T linkages (e.g. Funk, 2018).

The disciplinary origin of the contributing science is an important factor in influencing the pattern and intensity of knowledge transfer from technologies (McMillan et al. 2000; Bekkers and Bodas Freitas 2008). However, many other data-related factors or external determinants may have affected the numbers of citation frequencies; clearly further studies are required to ascertain the reliability and validity of those findings.

The main analytical goal is produce a series of data arrays ('S/T linkage tables') that connect technology areas to scientific disciplines. Each S/T linkage table consists of an array of pairwise data cells ('S/T pairs'), where each pair consists of a cited discipline and citing area. Each cell contains numerical information on the strength of the S/T link between the respective discipline and area. Citations to publications in journals that are assigned to multiple research domains and scientific disciplines will be counted as one link for each discipline. Similarly, patents spanning several technology domains and areas are also counted more than once in case of multiple occurrences.

2.2 Technology areas and scientific disciplines

The S/T linkage analysis is done at the level of 41 'technology areas' as presented in Table 1. Each area was delineated in terms International Patent Classification (IPC) codes. See Appendix A for details. Three variants of two areas (Industrial Biotechnology; Nanotechnology) were analysed to assess possible effects of slightly different delineations.

The science side of the S/T linkage table comprises of 35 'scientific disciplines' as developed by CWTS (Leiden University) – see Table 2. The selection includes STEM disciplines (Science, Technology, Engineering, Mathematics) as well as non-STEM disciplines in the social sciences and humanities. These disciplines are based on Clarivate Analytics' Journal Subject Categories, an internationally-used stable system with some 260 'subdisciplines', each containing a large set of scientific and technical journals (usually in the hundreds).

Some of these disciplines are far more likely to contribute to technological development that others. The share of the various technology areas and scientific fields in the S/T linkages is shown in subsection 3.1.

TECHNOLOGY AREA	SUB-AREA	DELINEATION*
Nanotechnology		a; b; c
Industrial biotechnology		a; b; c
Photonics		a
Advanced materials		a
Micro- and nanoelectronics		a
Advanced manufacturing technologies		a
Chemical engineering		b
Computer technology		b
Digital communication		b
Environmental technology		b
Food chemistry		b
Optics		b
Pharmaceuticals		b
Macromolecular chemistry, polymers		b
AI technology		С
High speed network	digital communication technique	с
	exchange, selecting	C
	others	C
Mobile communication security	cyphering, authentication	с
	electronic payment	С
Sensor and device network	sensor network	С
	electronic tag	С
	others	С

Table 1. Selected technology areas

High speed computing		С
Large-capacity and high		
speed storage		C
Large-capacity information	database	с
analysis		, ,
	data analysis, simulation,	с
	management	
Cognition and meaning		с
understanding		
Human interface		С
Imaging and sound	imaging technique	с
technology		
	sound technique	С
Information communication	electronic circuit	с
device		
	cable and conductor	С
	semiconductor	С
	optic device	С
	others	С
IoT and related technology		С
Electronic measurement		С
Others	computer input-output	С
	other related technique	С
Robotics and autonomous		_
systems		С
* Source of delineation: (a) EC	concordance table; (b) WIPO concor	dance table; (c) OECD

concordance tables.

Table 2. Selected scientific disciplines

STEM DISCIPLINES	NON-STEM DISCIPLINES
Agriculture and Food Science	
Astronomy and Astrophysics	Creative Arts, Culture and Music
Basic Life Sciences	Economics and Business
Basic Medical Sciences	Educational Sciences
Biological Sciences	History, Philosophy and Religion
Biomedical Sciences	Information and Communication Sciences
Chemistry and Chemical Engineering	Language and Linguistics
Civil Engineering and Construction	Law and Criminology
Clinical Medicine	Literature
Computer science	Management and Planning
Earth Sciences and Technology	Political Science and Public Administration
Electrical Engineering and Telecommunication	Psychology
Energy Science and Technology	Social and Behavioral Sciences -
Environmental Sciences and Technology	Interdisciplinary
General and Industrial Engineering	Sociology and Anthropology
Health Sciences	Statistical Sciences
Instruments and Instrumentation	
Mathematics	Other:
Mechanical Engineering and Aerospace	Multidisciplinary journals*
Physics and Materials Science	
Mathematics Mechanical Engineering and Aerospace	Multidisciplinary journals*

* General journals with a multidisciplinary content (e.g. *Nature, Science, PNAS*, etc.)

2.3 Data sources

Information on citing patents and cited publications is derived from databases at CWTS (Leiden University, Netherlands). The patents are extracted from the PATSTAT database, where only PCT/WIPO patents are selected thus creating a 'level playing field' to compare countries and geographical areas worldwide (the patents filed/granted in national patenting systems are removed). Our analysis relates to 'PCT patent families' only in order to remove duplicate patents; such a family consists of at least one PCT patent (among patents filed at other patent systems).

The research publications are extracted from the Clarivate Analytics owned and CWTS-licensed Web of Science (WoS) database, more specifically the Science Citation Index Expanded, Social Sciences Citation Index and Arts & Humanities Citation Index. As with patents, publication data are a fairly well-developed metric (comprehensive, long-term and internationally comparable data). See Appendix B for more technical information on how these two databases were matched in order to conduct S/T linkage analyses.

Having linked PATSTAT to the WoS, the CWTS 'Science/Technology information system' contains some 1.7 million unique micro-level citations at the level of individual (PCT) patents and cited WoS-indexed publications.3 The derivative, aggregate-level 'S/T pairs' relate to the number of patents in a citing technology area that are linked to a cited scientific discipline.

2.4 Trends analysis: methodology and presentation

In the line with the primary research question (is recent technological development benefitting more from science?), the analysis of S/T pairs is done from the perspective of citing patents and their related technology areas.

The trend analysis of 21st century S/T linkages comprise of three successive 5-year periods: 2000-2004, 2005-2009 and 2010-2014. Discerning patterns across these three year-blocks provides empirical evidence on how patented technologies interrelate to published scientific research and – by assumption – technological development is benefitting from scientific progress. This year-block approach captures 'structural' trends and avoids an emphasis on chance findings that emerge from volatile (bi)annual changes.

The data analysis compares two supranational geographical regions: 'OECD area' and EU28 area'. In each case, a patent is assigned to that area if it mentions at least one

³ Many of those patents are cited subsequently by other patents. Large quantities of these 'forward citations' indicate the degree to which a citing patent in an S/T pair represents a 'highly cited' technological development. The same applies to the research publications: the extent to which it is cited in science by other publications may indicate a highly cited scientific breakthrough. Applying this 'highly cited' approach enables measures of 'R&D excellence' to compare countries and universities in terms of their level science-based innovativeness (Tijssen and Winnink, 2017). The countries and universities that produce the science that is cited in the world's most highly cited patents, tend to be research powerhouses of new inputs for advanced technological development.

country from that area in the address list of the patent applicants.4 The comparative results, presented in the next section of the report, will start with the OECD area, representing 'worldwide' S/T Linkage patterns, followed by the same set of outputs for the EU28 area, which represented 'European' S/T Linkage patterns. Significant differences between both areas will be highlighted in the accompanying text. The tables with the main findings will be numbered pairwise.

Most of the analysis relates to the S/T linkage patterns and trends – either at the level of citing technology areas, cited scientific disciplines, or individual S/T pairs. The computational analysis does not deal with the increases in absolute numbers of patent citation occurrences, which – because of the nature of the data – tend to decline significantly as one moves nearer to the present, but rather of changes in relative sense.

The rate of decline is taken as an S/T linkage indicator in the first trend analysis: 2005-2009 versus 2000-2004. S/T pairs with relatively low rates of decline (or even growth), in spite of overall decline across all areas and disciplines, are seen as becoming more strongly linked. Moving towards the present-day situation, a systematic comparative analysis of patent citation frequency data breaks down because of the low absolute numbers involved. What remains is a comparison of relative shares – the contribution of a scientific discipline to all disciplines cited by patents. If the share goes up, one may assume that – relatively speaking – that discipline has become more relevant for technological development. This S/T strengthening' analysis is presented in subsection 3.1.

The other part of the trend analysis captures general patterns across all three timeperiods, by extracting data from two distributional processes within the portfolio of cited scientific disciplines per technology area. This analysis involves 'S/T broadening', where an increasing diversity of disciplines are becoming a major contributor to an area, or 'S/T narrowing' where the reverse happens (see subsection 3.2).

2.5 Cautionary notes

With S/T linkages now expressed in terms of these S/T pairs and the frequency of citation occurrence counts, it is technically feasible to gain some insight into longer-term trends in the relationships between science and technology. By looking at general trends that emerged in the early 2000s, that may have persisted in the recent past, it is possible to detect patterns that are likely to have continued up until the recent past.

However, these data should be handled with care. The analytical power of S/T linkage analysis is subject to several caveats and disclaimers. Particular attention shall be paid to the following inherent biases in patent and research publication data:

⁴ The scarcity of the S/T linkage data, especially in the 2010-2014 period, prevents a reliable and meaningful analysis at the level of the individual countries, with the exception of the world's largest nations.

- Patents and research publications are both proxies; of technological development and scientific research respectively. Hence, one should be cautious when interpreting the data and drawing strong conclusions with regards to specific cells in the data table. Hence, data analysis should focus on identifying general patterns and trends.
- Rows, columns or cells in a S/T linkage tables may suffer from low frequency counts. Small changes, from year to year or across time-periods, may lead to significant but nonsensical growth/decline rates. The statistics can easily become unreliable. A robust analysis of trends should take this caveat into account; implementing lower thresholds for S/T linkages removes S/T pairs with insignificant numbers of patent citation occurrences which may also have occurred because of database biases or small-scale chance events.
- Not all science-related technological developed are (adequately) covered by patents, especially in technology areas that benefit only indirectly from 'basic' discovery-oriented science. In many cases the scientific inputs are from 'applied science' or from engineering research. The latter inputs are usually difficult to detect in patent reference lists because the associated publications cannot be matched to large international bibliographical databases such the Web of Science or Scopus. STEM disciplines are much better represented in the research literature cited by patents, due to the nature of technological development and the technologies that are protected by patents.

Focussing on the analysis of 21st century S/T trends, the key issue driving this analysis and the focus of this report, patent citation data come with several important restrictions:

- Not all science-related technological developments are (adequately) covered by patents, especially in technology areas that benefit only partially or indirectly from science.
- The research publications cited in patents and indexed in the Web of Science database tend to reflect 'basic' discovery-oriented or curiosity-driven research. Application-oriented research and applied (engineering) research are underrepresented.
- The collected empirical data on relationships and links between technology and science are time-dependent; as one moves to the current year the number of citations in patents to research publications declines rapidly because of 4 or 5-year time-delays in knowledge transfer and utilization processes, which constrains longitudinal analysis up until recent years (the time-window for reliable trend analyses closes, effectively, around 2013 or 2014).

3 Main empirical findings

3.1 Distribution of S/T links across technology areas and scientific disciplines

Collecting all patent citations across the 15-year time-period, Table 3 presents the percentage share of each technology area in the total number of patents citing the scientific research literature.5 Pharmaceuticals and Industrial biotechnology account for almost half of these S/T links. The other relatively large areas are: Advanced Manufacturing Technologies; Computer technology; Micro and nanoelectronics; Information communication device- Semiconductor; and Advanced materials. The 'Biopharmaceuticals' sector and 'Electronics/Semiconductors' sector account for three-quarters of all links between patented technologies and published science. The Chemicals sector is the third major sector (Chemical engineering; Food chemistry; Macromolecular chemistry, polymers). A split is made between the shares within patents from countries in the OECD area and those from EU28 member states. The results highlight some significant differences between the global and European distribution, notably the much larger share of Industrial biotechnology in Europe.

Table 4 exhibits the breakdown from the perspective of the cited scientific disciplines. The top seven disciplines also account for 80% of the S/T links, mirroring the above three sectors: Biopharmaceuticals (Basic life sciences; Biomedical sciences; Clinical medicine; Basic medical sciences); Electronics/Semiconductors (Physics and materials science; Electrical engineering and telecommunication; Computer sciences); Chemicals (Chemistry and chemical engineering; Agriculture and food science). The EU28 has a relatively large share of science links related to the Biopharmaceuticals and Chemicals.

Table 5. Share of technology areas in 5/1 tinkages, 2000-2014 (%)		
	OECD	EU28
Pharmaceuticals	22.67	23.27
Industrial biotechnology (EC delineation)	22.41	38.23
Advanced Manufacturing Technologies	5.76	3.47
Computer technology	5.16	3.69
Micro and nanoelectronics	4.07	2.26
Information communication device - semiconductor	3.57	1.89
Advanced materials	3.42	2.91
Imaging and sound technology - imaging technique	2.94	1.47
Chemical engineering	2.71	2.79
Food chemistry	2.61	2.79
Macromolecular chemistry, polymers	2.15	2.03
Photonics	1.90	1.29
Large-capacity information analysis - data analysis simulation management	1.88	1.19

Table 3. Share of technology areas in S/T linkages, 2000-2014 (%)

⁵ To compute these shares two of the three delineations of 'Industrial biotechnology' and 'Nanotechnology' (WIPO, EC and OECD) were removed. Somewhat arbitrarily the EC delineation was kept for calculations. Sensitivity analysis, i.e. removing either one of the three delineations, has no significant effects on the outcome.

Human interface	1.81	1.18
Optics	1.80	1.34
High speed network - digital communication techniques	1.65	1.33
Cognition and meaning understanding	1.60	1.32
Digital communication	1.27	1.27
Nanotechnology (EC delineation)	1.13	0.65
High speed computing	1.07	0.25
Information communication device - optic device	0.90	0.59
Environmental technology	0.89	1.01
Large-capacity and high speed storage	0.78	0.21
High speed network – others	0.73	0.40
AI technology	0.71	0.25
IoT and related technology	0.60	0.45
Others - other related techniques	0.60	0.20
Mobile communication	0.52	0.50
Large-capacity information analysis - database	0.50	0.26
Information communication device - others	0.35	0.21
Electronic measurement	0.35	0.31
Security - Cyphering authentication	0.34	0.25
Information communication device - electronic circuit	0.32	0.16
Imaging and sound technology - sound technique	0.26	0.26
Sensor and device network - electronic tag	0.14	0.06
High speed network - exchange selecting	0.12	0.10
Sensor and device network - sensor network	0.11	0.07
Security - electronic payment	0.08	0.04
Others - computer input output	0.06	0.01
Sensor and device network - others	0.05	0.00
Robotics and Autonomous Systems	0.04	0.04

Table 4. Share of scientific disciplines in S/T linkages, 2000-2014 (%)

	OECD	EU28
Basic life sciences	16.22	16.97
Physics and materials science	13.13	9.07
Chemistry and chemical engineering	12.83	13.77
Biomedical sciences	11.92	15.29
Clinical medicine	11.06	13.45
Electrical engineering and telecommunication	10.35	6.33
Computer sciences	6.34	4.37
Multidisciplinary journals	4.71	4.23
Basic medical sciences	3.37	5.79
Biological sciences	2.40	2.37
Agriculture and food science	1.97	2.55
Instruments and instrumentation	0.93	0.90
Energy science and technology	0.91	1.17
Environmental sciences and technology	0.73	0.97

Mechanical engineering and aerospace	0.71	0.59
Earth sciences and technology	0.62	0.50
General and industrial engineering	0.39	0.33
Health sciences	0.31	0.47
Mathematics	0.26	0.21
Statistical sciences	0.25	0.18
Psychology	0.13	0.15
Civil engineering and construction	0.11	0.11
Information and communication sciences	0.08	0.03
Economics and business	0.06	0.02
Management and planning	0.05	0.01
Law and criminology	0.04	0.05
Educational sciences	0.03	0.02
Astronomy and astrophysics	0.02	0.03
Language and linguistics	0.02	0.01
Sociology and anthropology	0.01	0.01
Social and behavioral sciences - interdisciplinary	0.01	0.01
Creative arts, culture and music	0.01	0.01
History, philosophy and religion	0.01	0.01
Political science and public administration	0.01	0.00
Literature	0.00	0.00

3.2 Trends analysis – part 1: S/T strengthening

3.2.1. Patterns and trends in the OECD area

As a result of inherent time-lags in patenting procedures and delays in knowledge dissemination processes, the total number of citations from patents to STEM scientific disciplines declines as we approach the current era. This 'attrition rate' is quite high within the OECD area, where the number of patents that cite scientific research almost halved from 1.974.586 in the years 2000-2004 to 1.062.045 in 2005-2009, and dropped further still to 325.726 in 2010-2014.

As the total number of S/T links within the OECD area having declined by almost 50% between the first two periods, any S/T pair with a significant positive growth rate in 2005-2009, relative to the number of citation links in 2000-2004, is considered a 'fast-growth' pair. Adopting a more stringent criterion, set at 50% growth of the 2000-2004 level, and applying lower threshold of at least 50 patent citations per S/T pair in 2005-2009, only four technology areas contain 'fast-growth' scientific discipline in terms of citation increase: Imaging and sound technology - imaging technique (20 disciplines); Nanotechnology - all three delineations (3 disciplines); Imaging and sound technology - sound technique (1 discipline); Large-capacity and high speed storage (1 discipline). The S/T pair with the largest growth rate (127%) is patents in the area Imaging and sound technology - imaging technique which is citing research in Civil Engineering and Construction.

Further analysis is required to ascertain the reasons for this outcome. Why, for example, only these four areas? And what explains the remarkable position of

Imaging and sound technology - imaging technique. An in-depth follow-up study should distinguish the effects of possible modifications in patenting legislation, IPR practices, or patent classification systems from actual changes in S/T relationships. Table 5 lists the S/T pairs mentioned above in the OECD area, the majority of which are concentrated in just two technology areas: Imaging and sound technology - imaging technique; Nanotechnology. On the science side, Energy science and technology is prominent.

The analysis of noticeable trends between 2005-2009 and 2010-2014 is restricted to those technology areas cases where at least one scientific discipline became significantly more important as compared to other disciplines. More specifically, where the 'strength' of the S/T pair - the share of a scientific discipline in the total number of patent citations from a technology area - increased by more than 50%. For example, an increase from a 2% share to 3%, or from 10% to a 15% share. Again, the analysis is anchored to sizeable S/T pairs with at least 50 citations in 2010-2014.

A total of 23 S/T pairs meet these two selection criteria – see Table 6 for the OECD area.6 Again, more than half of these 'relative' fast grower pairs are concentrated in Energy science and technology, and in Environmental sciences and technology; 18 cases in all. The rise of these two disciplines in technological development, indicated in the previous subsection, has continued in more recent years. The third domain on the rise is Instruments and instrumentation. The vast majority of these pairs have growth rates between 50% and 100%. The largest growth rates, more than a doublina. occurred in three cases: Environmental sciences and technology/Information communication device - semiconductor, and Environmental sciences and technology/Micro and nanoelectronics, Electrical engineering and telecommunication/Sensor and device network - electronic tag.

TECHNOLOGY AREA	SCIENTIFIC DISCIPLINE	
Imaging and sound techn imaging technique	Agriculture and food science	
	Basic life sciences	
	Basic medical sciences	
	Biological sciences	
	Biomedical sciences	
	Clinical medicine	
	Basic medical sciences	
	Chemistry and chemical engineering	
	Civil engineering and construction	
	Computer science	
	Electrical engineering and	
	telecommunication	
	Energy science and technology	

Table 5. Selected high-growth technology areas between 2000-04 and 2005-09: OECD area*

⁶ The three delineations of 'Nanotechnology' and of 'Industrial Biotechnology' are counted as a single area.

	Environmental sciences and	
	technology	
	Earth sciences and technology	
	General and industrial engineering	
	Instruments and instrumentation	
	Mechanical engineering and	
	aerospace	
	Mathematics	
	Statistical sciences	
	Psychology	
Nanotechnology (all three delineations)	Energy science and technology	
	Environmental sciences and	
	technology	
	General and industrial engineering	
Imaging and sound techn sound technique	Chemistry and chemical engineering	
Large-capacity and high speed storage	Energy science and technology	

* Data analysis parameters: countries in the OECD area; 2005-2009 vs 2000-2004; S/T pairs with minimum of 50 patent citations in 2005-2009.

Have some scientific disciplines becoming increasingly important for a particular technological area? The large observed growth rates suggest processes of 'S/T strengthening', where scientific disciplines that are becoming increasingly intertwined with a particular technological area. Such a case of S/T strengthening is operationalized here in terms of increasingly large share of patent citations since the years 2000-2004. Comparing the lists of S/T pairs in tables 5 and 6, only one pair hints of such a possible process: we find that both Energy science and technology, and Environmental sciences and technology have increased their presence as contributing knowledge-production domains to Nanotechnology patents. The contribution increased by 50-60% between 2000-2005 and 2005-2009. But that share was still at very low level: between 1 and 2% in 2005-2009. The latter period, in 2010-2014, saw further growth (see Table 6), but clearly the contribution of these two is still small compared to the two dominant disciplines that contribute most to Nanotechnology: Chemistry and chemical engineering, and Physics and materials science (both with 30-35% shares of the total).

TECHNOLOGY AREA	SCIENTIFIC DISCIPLINE
Advanced manufacturing technologies	Energy science and technology
Advanced materials	Energy science and technology
AI technology	Agriculture and food science
	Physics and materials science
Cognition and meaning understanding	Instruments and instrumentation
Digital communication	Instruments and instrumentation
Electronic measurement	Instruments and instrumentation
Food chemistry	Energy science and technology
High speed network - digital comm.	
techniques	Instruments and instrumentation
High speed network - exchange selecting	Physics and materials science

Table 6. High-growth S/T pairs between 2005-2009 and 2010-2014: OECD area*

High speed network - others	Instruments and instrumentation		
Human interface	Instruments and instrumentation		
Industrial biotechnology (all three			
delineations)	Energy science and technology		
Information communication device –			
semiconductor	Energy science and technology		
Large-capacity information analysis -			
database	Chemistry and chemical engineering		
Macromolecular chemistry, polymers	Energy science and technology		
	Environmental sciences and		
	technology		
Micro and nanoelectronics	Energy science and technology		
	Environmental sciences and		
	technology		
Nanotechnology	Energy science and technology		
	Environmental sciences and		
	technology		
Optics	Basic medical sciences		
Sensor and device network - electronic			
tag	Energy science and technology		

* Data analysis parameters: countries in the OECD area; 2005-2009 vs 2010-2014; S/T pairs with minimum of 50 patent citations in 2005-2009.

3.2.2 Patterns and trends in the EU28 area

The decline in number citations from patents to STEM research publications is less dramatic in the case of the European Union, where the total dropped from 194.321 in 2000-2004 to 178.574 in 2005-2009, and down to 84.748 in 2010-2014. Clearly the EU area is subject to a much less severe attrition process as compared to the steep decline observed in the OECD area.⁷

Although the total number of S/T links within the EU28 have declined by only 11% between the first two periods, the same selection criterion is adopted as in the previous analysis of the OECD area: only those S/T pairs are taken into consideration if they exhibit a 50% growth rate between 2000-2004 and 2005-2009, and consist of at least 50 patent citations in 2005-2009. In the case of the EU28 one finds no less than 25 technology areas that contain at least one fast-growth scientific discipline. The following four areas have 4 or more of those fast-growers: Industrial biotechnology – OECD delineation (5 disciplines); Advanced materials (4 disciplines); Pharmaceuticals (4 disciplines); Industrial biotechnology – WIPO delineation (4 disciplines). The S/T pair with the largest growth rate (216%) is the technology area 'Industrial biotechnology – OECD delineation' citing research in 'Energy Science and Technology'.

⁷ Over time, the relative quantity of citing patents from the EU28 countries has, as compared to the OECD total, steadily increased: from 9% in 2000-2004 to 24% in 2010-2014. A comprehensive explanation for this growth requires further research, which is beyond the scope of this exploratory study.

Covering all technology areas, contrary to the OECD analysis in Table 5, Table 7 lists the S/T pairs with growth rates of 75% or more. The overview shows a diversity of technology areas and disciplines. Some scientific disciplines have become more prominent as cited sources - three scientific disciplines in particular: Energy science and technology; Mechanical engineering and aerospace; Basic life sciences.

TECHNOLOGY AREA	SCIENTIFIC DISCIPLINE		
Advanced manufacturing technologies	Mechanical engineering and aerospace		
Advanced materials	Mechanical engineering and aerospace		
	Physics and materials science		
Chemical engineering	Mechanical engineering and aerospace		
Cognition and meaning understanding	Earth sciences and technology		
Electronic measurement	Computer science		
Environmental technology	Agriculture and food science		
Food chemistry	Energy science and technology		
Industrial biotechnology (all three delineations)	Energy science and technology		
Industrial biotechnology (two delineations)	Basic medical sciences		
Information communication device - semiconductor	Energy science and technology		
Macromolecular chemistry, polymers	Energy science and technology		
Nanotechnology (all three delineations)	Basic life sciences		
Optics	Basic life sciences		
Nanotechnology (all three delineations)	Chemistry and chemical engineering		
Nanotechnology (OECD delineation)	Physics and materials science		
Pharmaceuticals	Agriculture and food science		
	Computer science		

Table 7. High-growth S/T pairs between 2000-04 and 2005-09: EU28 area*	growth S/T pairs between 2000-04 a	nd 2005-09: EU28 area*
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* Data analysis parameters: countries in the EU28 area; 2005-2009 vs 2000-2004; S/T pairs with minimum of 50 patent citations in 2005-2009.

Extending the trend analysis to changes between 2005-2009 and 2010-2014, Table 8 compares the last pair of time-periods. Similarly to the OECD case, the analysis is restricted to those technology areas where the 'strength' of the S/T pair (share of a scientific discipline in the total number of patent citations from a technology area) increased by 50% or more. Eight S/T pairs meet these two selection criteria.

As in the OECD area, more than half of these fast grower pairs are concentrated in Energy science and technology, and in Environmental sciences and technology. Only Energy science and technology has continued to rise in more recent years. The vast majority of these pairs have growth rates between 50% and 100%. The largest growth rate, more than a doubling (110%), happened in the pair Macromolecular chemistry, polymers/Energy science and technology.

Table 6. High growth 5/1 pairs between 2005 200			
TECHNOLOGY AREA	SCIENTIFIC DISCIPLINE		
	Environmental sciences and		
Advanced materials	technology		
Cognition and meaning understanding	Basic life sciences		
Environmental technology	Agriculture and food science		
Food chemistry	Energy science and technology		
Industrial biotechnology (all three			
delineations)	Energy science and technology		
	Environmental sciences and		
	technology		
Macromolecular chemistry, polymers	Energy science and technology		
	Environmental sciences and		
	technology		

Table 8. High-growth S/T pairs between 2005-2009 and 2010-2014: EU28 area*

* Data analysis parameters: countries in the OECD area; 2005-2009 vs 2010-2014; S/T pairs with minimum of 50 patent citations in 2005-2009.

Overall, the EU28 'S/T strengthening' profile is quite different from the OECD findings. There are some similarities of course (since several EU members are also OECD member): the significant emergence of Energy science and technology throughout those 15 years, and the rise of Environmental sciences and technology in more recent years. The findings reveal continued strengthening of the links between Macromolecular chemistry, polymer and Energy science and technology, as well as between Industrial biotechnology and Energy science and technology.

3.3 Trends analysis – part 2: S/T broadening or S/T narrowing

3.3.1 Introduction

As emerging technologies start to mature, some may increase their technical complexity or broaden their scope of application. Such processes may result in a growing need for a diversity of inputs from scientific research. Some technologies may require innovative, interdisciplinary research. In those cases one would expect to see a larger number of scientific disciplines being cited in patents as years go by. Conversely, some maturing 'specialised' technologies may develop trajectories where their existing 'core disciplines' become increasingly important, while other 'fringe disciplines' gradually fade away as contributors.

Take for example the four technology areas in Table 3a that show increased activity in multiple scientific disciplines: AI technology has increasingly tight links to Agriculture and food science, and to Physics and materials science. Three other areas (Macromolecular chemistry and polymers, Micro and nanoelectronics, and Nanotechnology) share increasing contributions from Energy science and technology, and from Environmental sciences and technology. Has science-based technological development in these cases become more 'broader' in terms of their science base? Is that source of information becoming more 'multi-disciplinarity' or 'crossdisciplinarity'? A close look at the disciplinary distribution of citations by the patents of a technological area may reveal interesting clues about such 'S/T broadening' effects. To address this issue, the trend analysis examined such changes across the three time-periods (2000-2004, 2005-2009 and 2010-2014). The measurement method counts the number of 'major cited scientific disciplines' per citing technology area, that is those STEM disciplines take account for at least 5% of the S/T links per area and per time-period.

S/T broadening then entails an increasingly large number of such 'major' scientific disciplines. Starting from the baseline in 2000-2004, technology areas characterised by S/T broadening would exhibit consistent significant growth of disciplines in 2005-2009 and/or 2010-2014, where 'consistent significant growth' is operationalised as having at least two major disciplines more than the 2000-2004 benchmark value. Conversely, those technology areas affected by 'S/T narrowing' show a declining number of citing disciplines.

3.3.2 Patterns and trends in the OECD area

Table 9 presents the list of technology areas where either process has occurred within the OECD area, along with the number of associated STEM disciplines per time period. Interestingly, we find similar levels of broadening and narrowing across all technology areas. The number of scientific disciplines involved in broadening processes has increased. Where the 2000-2004 period consisted of nine major contributing scientific disciplines, the number went up to 10 in 2005-2009, and further increased to 13 in 2010-2014. Note that the disciplines involved in broadening where found mainly in the medical/health/life sciences domains, whereas narrowing tends to occur in natural sciences, engineering sciences and Computer science.

Comparing the 2000-2004 and 2005-2009 data we find three new entrants: Clinical medicine (in the technology area 'Human interface'), Environmental sciences and technology (in Chemical engineering), Physics and materials science (in 'Large-capacity information analysis - data analysis simulation management' and in 'Digital communication'). As for changes between 2005-2009 and 2010-2014, 'Security - Electronic payment' presents an interesting case with increases in Agriculture and food science (from 2% to 6% in 2010-2014), Basic life sciences (from 2% to 6%) and chemistry and chemical engineering (from 3% to 7%). The two largest scientific disciplines of this technology area remain the same: Computer science (28% in 2010-2014) and Electronic and electrical engineering (21%).

As for S/T narrowing trends within the OECD, also afflicting six technology areas, here we find six scientific disciplines 'in retreat' as major contributors and being replaced by other scientific disciplines. While Chemistry and chemical engineering gained importance in some technology areas during the period 2001-2010, the share of several other disciplines declined: Biomedical sciences; Electrical engineering and telecommunications; Mechanical engineering and aerospace; and Physics and materials science. Since 2011, the latter two disciplines have lost further ground.

Table 9. Technology areas engaged in S/T broadening or S/T narrowing: OECD area*

	NUMBER OF MAJOR CITED SCIENTIFIC DISCIPLINES		
	2000-2004	2005-2009	2010- 2014
S/T broadening:			
Large-capacity information analysis - data			
analysis simulation management	6	7	7
Sensor and device network - electronic tag	6	6	7
Security - electronic payment	2	3	6
Chemical engineering	3	4	5
Human interface	4	5	5
Digital communication	2	3	3
S/T narrowing:			
Sensor and device network - sensor network	3	2	2
Macromolecular chemistry, polymers	4	3	3
Nanotechnology (all three delineations)	4	3	3
Advanced manufacturing technologies	5	4	4
Imaging and sound technology - sound technique	5	5	4
Electronic measurement	7	7	6

* Data analysis parameters: countries in the OECD area; major cited scientific disciplines with a share of at least 5% per technology area; STEM disciplines only.

3.3.3 Patterns and trends in the EU28 area

The EU28 overview in Table 10 shows much less technology areas engaged in broadening or narrowing. Patents from Europe seem to be less dynamic (volatile?) in terms of their changing citation links to science. Of the three technology area that show signs of broadening, one is also on the OECD list (see Table 7): Large-capacity information analysis - data analysis simulation management. Nanotechnology, irrespective of how this area is delineated, is narrowing; the same pattern occurs in the OECD area.

Table 10. Technology areas engaged in S/T broadening or S/T narrowing: EU28 area*

	NUMBER OF MAJOR CITED SCIENTIFIC DISCIPLINES		
	2000-2004	2005-2009	2010- 2014
S/T broadening:			
Large-capacity information analysis - data			
analysis simulation management	6	8	9
Cognition and meaning understanding	4	6	6
Robotics and autonomous systems	3	4	5
S/T narrowing:			
Nanotechnology (WIPO delineation)	6	5	3
Nanotechnology (EC delineation)	6	4	3
Nanotechnology (OCED delineation)	5	3	3

* Data analysis parameters: countries in the EU28 area; major cited scientific disciplines with a share of at least 5% per technology area; STEM disciplines only.

The most remarkable outcome are the two technology areas (Cognition and meaning understanding, Robotics and autonomous systems) where Europe differs from worldwide trends. Comparing 2000-2004 to 2005-2009 in the case of Cognition and meaning understanding, the two new scientific disciplines represent minor increases in relevance: Clinical Medicine (from 4.6% to 6.4%) and Physics and materials science (from 4.6% to 5.3%). As for Robotics and autonomous systems, this area produces low number of citations of research publications in (less than 100 per 5 years) which renders these data unreliable for trend analysis.

3.4 Special case studies

3.4.1 Artificial Intelligence

Artificial Intelligence (AI) is usually defined as the branch of computer science that is concerned with the automation of intelligent behaviour (Luger & Stubblefield, 1993). It is sometimes referred to as machine intelligence; intelligence demonstrated by machines. AI is a research area and a field of technology that creates both software and hardware sophisticated features in order to include virtual artificial agents. 21st century development in AI has experienced a resurgence following concurrent advances in computer power, large amounts of data, and theoretical understanding. As such, advanced AI technologies have become an essential part of the technology industries, helping to solve many challenging problems in computer science.

Looking at those 21st century developments from the perspective of S/T linkages and patent citations from the OECD area, the share of the technology area 'AI technology' in the total number of patents that cite scientific research literature has gradually decreased from 0.78% in 2000-2004, to 0.63% in 2005-2009, to 0.51% in 2010-2014.8 It seems that AI technology is becoming less linked to science, relative to the general worldwide trend across all technology areas, as time progresses. The EU28 picture is different: is shows the same share (around 0.25%) throughout the entire 15 years.

Following the above analytical design (in subsections 3.2 and 3.3), Table 11 summarizes the share of the scientific disciplines in the patent citations from this technology area. The findings, from the OECD area, show large differences between the contributions of disciplines. Some disciplines have lost some ground as a contributor, including the no 1 source: Computer science. Some disciplines seem to have gained importance. Notably Chemistry and chemical engineering, Biological sciences, and Agriculture and food science. But to a lesser extend also: Energy science and technology, and Civil engineering and construction. Overall, there are signs of a gradual shift towards more contributions from the chemistry and the life sciences.

⁸ In the computation of the total number of citing patents, across all technology areas, a choice had to be made with regards to removing delineations of 'Industrial biotechnology' and 'Nanotechnology' (WIPO, EC and OECD). Somewhat arbitrarily the EC delineation was kept for calculations. Sensitivity analysis, i.e. removing either one of the three delineations, has no significant impact on the share of 'AI technology' in the total number of citing patents.

Table 11. S/T broadening or S/T narrowing in AI technology : DECD area			
	SHARE OF TOTAL CITING PATENTS		
	2010-	2005-	2000-
	2014	2009	2004
Computer science	29.2%	29.5%	36.8%
Electrical engineering and telecommunications	20.2%	18.8%	20.2%
Physics and materials science	7.7%	5.1%	5.3%
Biomedical sciences	6.7%	7.6%	5.3%
Basic life sciences	4.8%	5.0%	4.4%
Chemistry and chemical engineering	4.4%	3.4%	2.7%
Biological sciences	3.4%	2.8%	1.7%
Statistical sciences	2.3%	3.3%	2.3%
Clinical medicine	2.1%	4.0%	3.7%
Agriculture and food science	2.0%	1.1%	0.4%
Basic medical sciences	1.9%	2.4%	2.0%
Instruments & instrumentation	1.3%	1.4%	1.1%
Mathematics	1.3%	1.6%	1.3%
General and industrial engineering	1.2%	1.7%	1.9%
Mechanical engineering and aerospace	1.2%	1.5%	1.4%
Energy science and technology	1.0%	0.7%	0.5%
Civil engineering and construction	0.9%	0.7%	0.3%
Earth sciences and technology	0.8%	1.2%	1.2%
Psychology	0.7%	0.8%	0.8%
Health sciences	0.7%	1.1%	0.7%

Table 11. S/T broadening or S/T narrowing in 'AI technology': OECD area*

* Includes scientific disciplines that account for 0.5% or more in 2010-2014.

Table 12 presents the overview for the EU28 area, with the same gradual decline of Computer science, and the rise of Chemistry and chemical engineering and of Energy science and technology. However, several new features emerge, as compared to the OECD pattern: the rise of Physics and materials science; the decline of Biomedical sciences and of Clinical medicine, the rise of Instruments and instrumentation, and citations to a wider range of non-STEM disciplines in the lower regions of the distribution (Psychology; History, philosophy and religion; Sociology and anthropology). As far as the major contributing disciplines are concerned, the European picture is fairly similar to the OECD counterpart.

	SHARE OF TOTAL CITING PATENT		G PATENTS
	2010-2014	2005-2009	2000-2004
Computer science	25.5%	29.4%	34.3%
Electrical engineering and telecommunication	18.6%	20.1%	16.5%
Physics and materials science	11.8%	6.0%	8.7%
Biomedical sciences	5.0%	6.6%	7.2%
Chemistry and chemical engineering	5.0%	4.6%	3.9%
Basic life sciences	3.6%	4.2%	5.2%
Biological sciences	2.7%	2.2%	2.2%
Instruments and instrumentation	2.7%	1.8%	0.9%
Statistical sciences	2.7%	3.3%	1.1%

Earth sciences and technology	2.3%	2.7%	0.4%
Energy science and technology	2.3%	1.1%	0.9%
Mathematics	2.3%	1.5%	1.1%
Basic medical sciences	1.8%	3.3%	3.0%
Civil engineering and construction	1.8%	1.3%	0.4%
Clinical medicine	1.8%	2.0%	3.3%
General and industrial engineering	1.4%	2.7%	1.3%
Environmental sciences and technology	0.9%	1.1%	0.9%
Mechanical engineering and aerospace	0.9%	1.3%	1.5%
History, philosophy and religion	0.5%	0.0%	0.4%
Psychology	0.5%	0.7%	0.9%
Sociology and anthropology	0.5%	0.0%	0.0%

* Includes scientific disciplines that account for 0.5% or more in 2010-2014.

3.5 Internet of Things

Internet of Things (IoT) is seen by many as a new paradigm of information networks with the aim of expanding the scope of Web-based services. IoT focusses on interactions and information processing that occur predominantly between physical objects rather than between people. Web-based household appliances are a key example. IoT is at the center of attention in several political and economic debates (European Commission, 2009; OECD, 2015b), owing to its potential to boost business opportunities within and beyond the ICT sector.

able 13. S/I broadening or S/I narrowing in 'IoI and related technology': OECD area*			
SHARE OF TOTAL CITING			
	FAILINIS		
2010-	2005-	2000-	
2014	2009	2004	
51.5%	49.2%	46.4%	
36.9%	38.2%	42.0%	
1.4%	1.7%	2.1%	
1.3%	1.2%	0.9%	
1.3%	0.8%	0.5%	
1.2%	1.0%	0.9%	
0.8%	0.5%	0.4%	
0.6%	0.8%	0.6%	
0.6%	0.6%	0.7%	
0.5%	0.2%	0.1%	
0.5%	0.0%	0.0%	
	SHAI 2010- 2014 51.5% 36.9% 1.4% 1.3% 1.3% 1.2% 0.8% 0.6% 0.5%	SHARE OF TOTAL PATENTS 2010- 2005- 2014 2009 51.5% 49.2% 36.9% 38.2% 1.4% 1.7% 1.3% 1.2% 1.3% 0.8% 0.6% 0.5% 0.6% 0.6% 0.5% 0.2%	

Table 13. S/T broadening or S/T narrowing in 'IoT and related technology': OECD area*

* Includes scientific disciplines that account for 0.5% or more in 2010-2014.

The share of the technology area 'IoT and related technology' in the total number of patents that cite scientific research literature has gradually decreased within the

OECD area – from 0.63% during the years 2000-2004 to 0.53% in 2010-2014. 9 In contrast, the share in EU28 area shows a similar degree of stability (around 0.45%) throughout the entire period. Table 13 summarizes the share of the scientific disciplines in the patent citations from this technology area. These findings from the OCED area clearly indicate that the contribution from science is highly concentrated; two disciplines (Electrical engineering and telecommunication, and Computer science) account for almost 90% of the patent citations. The relative contribution of Electrical engineering and telecommunication has increased slightly. Several of the other 'minor' disciplines have also increased their share.

The EU28 pattern, in Table 14, shows same dominance of the two 'major' disciplines, but a smaller number of disciplines with a significant yet low-level contribution. Similarly to patents from the OECD area, the share of Computer science is also in decline.

Table 14. 5/1 broadching of 5/1 harrowing in 101 and related technology . Lozo area			
	SHARE OF TOTAL CITING PATENTS		
	2010-2014	2005-2009	2000-2004
Electrical engineering and telecommunication	54.3%	49.8%	51.0%
Computer science	39.5%	41.7%	42.2%
Instruments and instrumentation	1.6%	0.5%	0.1%
General and industrial engineering	0.8%	1.3%	1.0%
Physics and materials science	0.8%	1.2%	0.6%
Chemistry and chemical engineering	0.5%	0.4%	0.6%
Statistical sciences	0.5%	0.8%	0.5%

Table 14. S/T broadening or S/T narrowing in 'IoT and related technology': EU28 area*

* Includes scientific disciplines that account for 0.5% or more in 2010-2014.

⁹ See footnote 8.

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Appendix A - Sources of delineation of technology areas

A.1 EC concordance table

KETs	IPC classes
Nano-	B82Y (previously Y01N), B81C, B82B
technology Photonics	F21K, F21V, F21V, G01D 5/26, G01D 5/58, G01D 15/14, G01G 23/32, G01J, G01L 1/24, G01L 3/08, G01L 11/02, G01L 23/06, G01M 11, G01P 3/36, G01P 3/38, G01P 3/68, G01P 5/26, G01Q 20/02, G01Q 30/02, G01Q 60/06, G01Q 60/18, G01R 15/22, G01R 15/24, G01R 23/17, G01R 31/308, G01R 33/032, G01R 33/26, G015 7/481, G01V 8, G02B 5, G02B 6 (excl. subclasses 1, 3, 6/36, 6/38, 6/40, 6/44, 6/46), G02B 13/14, G03B 42, G03G 21/08, G06E, G06F 3/042, G06K 9/58, G06K 9/74, G06N 3/067, G08B 13/186, G08C 19/36, G08C 23/04, G08C 23/06, G08G 1/04, G11B 7/12, G11B 7/125, G11B 7/13, G11B 7/135, G11B 11/03, G11B 11/12, G11B 11/18, G11C 11/42, G11C 13/04, G11C 19/30, H01J 3, H01J 5/16, H01J 29/46, H01J 29/82, H01J 29/89, H01J 31/50, H01L 31/10, H01L 33/06, H01L 33/08, H01L 33/10, H01L 33/18, H01L 51/50, H01L 51/52, H015 3, H015 5, H02N 6, H05B 33
Industrial bio- technology	C02F 3/34, C07C 29, C07D 475, C07K 2, C08B 3, C08B 7, C08H 1, C08L 89, C09D 11, C09D 189, C09J 189, C12M, C12P, C12Q, C125, G01N 27/327 except for co-occurrence with A01, A61, C07K 14/435, C07K 14/47, C07K 14/705, C07K 16/18, C07K 16/28, C12N 15/09, C12N 15/11, C12N 15/12, C12N 5/10, C12P 21/08, C12Q 1/68, G01N 33/15, G01N 33/50, G01N 33/53, G01N 33/68, G01N 33/566, C12N 1/19, C12N 1/21, C12N 1/15, C12N 15/00, C12N 15/10, C12P 21/02.
Advanced materials	B32B 9, B32B 15, B32B 17, B32B 18, B32B 19, B32B 25, B32B 27, B82Y 30, C01B 31, C01D 15, C01D 17, C01F 13, C01F 15, C01F 17, C03C, C04B 35, C08F, C08J 5, C08L, C22C, C23C, D21H 17, G02B 1, H01B 3, H01F 1/0, H01F 1/12,
Micro- and nanoelectroni cs	H01F 1/34, H01F 1/42, H01F 1/44, H01L 51/30, H01L 51/46, H01L 51/54. G01R 31/26, G01R 31/27, G01R 31/28, G01R 31/303, G01R 31/304, G01R 31/317, G01R 31/327, G09G 3/14, G09G 3/32, H01F 1/40, H01F 10/193, H01G 9/028, H01G 9/032, H01H 47/32, H01H 57, H015 5, H01L, H03B 5/32, H03C 3/22, H03F 3/04, H03F 3/06, H03F 3/08, H03F 3/10, H03F 3/12, H03F 3/14, H03F 3/16, H03F 3/183, H03F 3/21, H03F 3/343, H03F 3/37, H03F 3/55, H03K 17/72, H05K 1, B82Y 25 (certain overlap to nanotechnology).
Advanced Manufacturing Technologies	B01D 15, B01D 67, B01J 10, B01J 12, B01J 13, B01J 14, B01J 15, B01J 16, B01J 19/02, B01J 19/08, B01J 19/18, B01J 20, B01J 19/22, B01J 19/24, B01J 20/30, B01J 21/20, B01J 23/92, B01J 23/94, B01J 38, B01J 38, B01J 39/26, B01J 41/20, B01J 47, B01J 49, B01J 8/04, B01J 8/14, B01J 8/24, B011 10, B01L, B04B, B04C, B32B 37, B32B 38, B32B 39, B32B 41, B81C 3, B82B 3, B82Y 35, B82Y 40, C01B 17/20, C01B 17/80, C01B 17/96, C01E 21/28, C01D 21/28, C01B 17/20, C01B 17/80, C01B 17/96, C01E 11/02, C02F 11/04, C01E 37/232, C01B 31/24, C01B 9, C01C 1/28, C01D 1/28, C01D 3/14, C01D 5/16, C01D 7/22, C01B 31/24, C01B 9, C01C 1/28, C01D 1/28, C01B 31/24, C01D 5/16, C01C 1/22, C01B 35/622, C04B 35/624, C03B 5/237, C03B 5/02, C03C 21, , C03C 29, C04B 11/028, C04B 35/622, C04B 35/624, C04B 35/624, C04B 35/625, C04B 37, C04B 37, C02B 5/173, C03B 5/27, C03B 5/02, C03C 21, , C03C 29, C04B 11/028, C04B 35/622, C04B 35/10, C04E 40, C04B 7/60, C04E 9/20, C07C 17/38, C07C 213/10, C07C 227/38, C07C 21/80, C07C 213/10, C07C 272/38, C07C 21/91, C07C 209/82, C07C 213/10, C07C 273/34, C07C 217/64, C07C 24/91, C07C 253/32, C07C 23/18, C07C 41/34, C07C 41/58, C07C 4/04, C07C 4/06, C07C 41/16, C07C 41/38, C07C 41/34, C07C 41/58, C07C 45/78, C07C 45/90, C07C 51/573, C07C 51/642, C07D 301/32, C07D 301/16, C07D 209/84, C07D 213/803, C07D 251/62, C07D 301/32, C07D 311/40, C07D 499/18, C07D 501/12, C07F 7/20, C07T 11/06, C07C 4, C22D 9, C22C 1, C22C 3, C22C 35, C22C 47, C22F 0, C23C 1, C22C 35, C22C 59, C22B 15/02, C25C , C25D 1, S00B 15/20, C03B 35, C40B 60, D01D 10, D01D 11, D01D 13, D01F 9/133, D01F 9/32, D06E 23/20, D21H 23/20, D21H 23/70, D21H 23/74,

Source: KETs Observatory (van de Velde et al. 2013).

A.2 WIPO concordance table

IPC8 -Technology Concordance

Note: In this update, code "G04R" had been added. Methodology available at: http://www.wipo.int/ipstats/en/statistics/patents/pdf/wipo_ipc_technology.pdf **Source:** WIPO Statistics Database

Last update: March 2018

Field_number	Field_en	IPC_code	Updated_on
1	Electrical machinery, apparatus,	F21H%	
	energy	FOALCO	
1	Electrical machinery, apparatus,	F21K%	
1	energy Electrical machinery, apparatus,	F21L%	
	energy	1 2 1 2 7 0	
1	Electrical machinery, apparatus,	F21S%	
	energy	5041/0/	
1	Electrical machinery, apparatus, energy	F21V%	
1	Electrical machinery, apparatus,	F21W%	
	energy	, .	
1	Electrical machinery, apparatus,	F21Y%	
	energy		
1	Electrical machinery, apparatus, energy	H01B%	
1	Electrical machinery, apparatus,	H01C%	
-	energy		
1	Electrical machinery, apparatus,	H01F%	
4	energy		
1	Electrical machinery, apparatus, energy	H01G%	
1	Electrical machinery, apparatus,	H01H%	
	energy		
1	Electrical machinery, apparatus,	H01J%	
1	energy		
I	Electrical machinery, apparatus, energy	H01K%	
1	Electrical machinery, apparatus,	H01M%	
	energy		
1	Electrical machinery, apparatus,	H01R%	
1	energy Electrical machinery, apparatus,	H01T%	
	energy		
1	Electrical machinery, apparatus,	H02B%	
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1	Electrical machinery, apparatus,	H02G%	
1	energy Electrical machinery, apparatus,	H02H%	
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1	Electrical machinery, apparatus,	H02J%	
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1	Electrical machinery, apparatus,	H02K%	
	energy		
1	Electrical machinery, apparatus,	H02M%	
1	energy		
1	Electrical machinery, apparatus, energy	H02N%	
1	Electrical machinery, apparatus,	H02P%	
•	energy	11021 70	
1	Electrical machinery, apparatus,	H02S%	June 10, 2014
	energy		
1	Electrical machinery, apparatus,	H05B%	
	energy	110-00/	
1	Electrical machinery, apparatus,	H05C%	
1	energy		
I	Electrical machinery, apparatus, energy	H05F%	
1	Electrical machinery, apparatus,	H99Z%	
•	energy	1100270	
2	Audio-visual technology	G09F%	
2	Audio-visual technology	G09G%	
2	Audio-visual technology	G11B%	
2	Audio-visual technology	H04N 3%	
2	Audio-visual technology	H04N 5%	
2	Audio-visual technology	H04N 7%	
2	Audio-visual technology	H04N 9%	
2	Audio-visual technology	H04N 11%	
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2	Audio-visual technology	H04N 15%	
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2	Audio-visual technology	H04N 19%	June 10, 2014
2	Audio-visual technology	H04N	
2	Audio-visual technology	101% H04R%	
2 2	Audio-visual technology	H048%	
2	Audio-visual technology	H043 %	
2	Telecommunications	G08C%	
3	Telecommunications	H01P%	
3	Telecommunications	H01Q%	
3	Telecommunications	H04B%	
3	Telecommunications	H04H%	
3	Telecommunications	H04J%	
3	Telecommunications	H04K%	
3	Telecommunications	H04M%	
3	Telecommunications	H04N 1%	
3	Telecommunications	H04Q%	
4	Digital communication	H04L%	
4	Digital communication	H04N 21%	
4	Digital communication	H04W%	
5	Basic communication processes	H03B%	

5	Pasic communication processos	H03C%
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	Basic communication processes	H03G%
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5	Basic communication processes	H03J%
5	Basic communication processes	H03K%
5	Basic communication processes	H03L%
5	Basic communication processes	H03M%
6	Computer technology	G06C%
6	Computer technology	G06D%
6	Computer technology	G06E%
6	Computer technology	G06F%
6	Computer technology	G06G%
6	Computer technology	G06J%
6	Computer technology	G06K%
6	Computer technology	G06M%
6	Computer technology	G06N%
6	Computer technology	G06T%
6	Computer technology	G10L%
6	Computer technology	G11C%
7	IT methods for management	G06Q%
8	Semiconductors	H01L%
9	Optics	G02B%
9	Optics	G02C%
9	Optics	G02F%
9	Optics	G03B%
9	Optics	G03C%
9	Optics	G03D%
9	Optics	G03F%
9	Optics	G03G%
9	Optics	G03H%
9	Optics	H01S%
10	Measurement	G01B%
10	Measurement	G01C%
10	Measurement	G01D%
10	Measurement	G01F%
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10	Measurement	G01N 29%	
10	Measurement	G01N 30%	
10	Measurement	G01N 31%	
10	Measurement	G01N 35%	
10	Measurement	G01N 37%	
10	Measurement	G01P%	
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10	Measurement	G04G%	
10	Measurement	G04R%	January 1,
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10	Measurement	G12B%	
10	Measurement	G99Z%	
11	Analysis of biological materials	G01N 33%	
12	Control	G05B%	
12	Control	G05D%	
12	Control	G05F%	
12	Control	G07B%	
12	Control	G07C%	
12	Control	G07D%	
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12	Control	G08B%	
12	Control	G08G%	
12	Control	G09B%	
12	Control	G09C%	
12	Control	G09D%	
13	Medical technology	A61B%	
13	Medical technology	A61C%	
13	Medical technology	A61D%	

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13	Medical technology	A61F%	
13	Medical technology	A61G%	
13	Medical technology	A61H%	
13	Medical technology	A61J%	
13	Medical technology	A61L%	
13	Medical technology	A61M%	
13	Medical technology	A61N%	
13	Medical technology	H05G%	
13	Medical technology	G16H%	January 1,
		10416 006	2018
14	Organic fine chemistry	A61K 8%	
14	Organic fine chemistry	A61Q%	
14	Organic fine chemistry	C07B%	
14	Organic fine chemistry	C07C%	
14	Organic fine chemistry	C07D%	
14	Organic fine chemistry	C07F%	
14	Organic fine chemistry	C07H%	
14	Organic fine chemistry	C07J%	
14	Organic fine chemistry	C40B%	
15	Biotechnology	C07G%	
15	Biotechnology	C07K%	
15	Biotechnology	C12M%	
15	Biotechnology	C12N%	
15	Biotechnology	C12P%	
15	Biotechnology	C12Q%	
15	Biotechnology	C12R%	
15	Biotechnology	C12S%	
16	Pharmaceuticals	A61K 6%	
16	Pharmaceuticals	A61K 9%	
16	Pharmaceuticals	A61K 31%	
16	Pharmaceuticals	A61K 33%	
16	Pharmaceuticals	A61K 35%	
16	Pharmaceuticals	A61K 36%	
16	Pharmaceuticals	A61K 38%	
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16	Pharmaceuticals		A61K 133%	
16	Pharmaceuticals		A61K 135%	
16	Pharmaceuticals		A61P%	
17	Macromolecular	chemistry,	C08B%	
17	polymers Macromolecular	chemistry,	C08C%	
17	polymers Macromolecular polymers	chemistry,	C08F%	
17	Macromolecular polymers	chemistry,	C08G%	
17	Macromolecular polymers	chemistry,	C08H%	
17	Macromolecular polymers	chemistry,	C08K%	
17	Macromolecular polymers	chemistry,	C08L%	
18	Food chemistry		A01H%	
18	Food chemistry		A21D%	
18	Food chemistry		A23B%	
18	Food chemistry		A23C%	
18	Food chemistry		A23D%	
18	Food chemistry		A23F%	
18	Food chemistry		A23G%	
18	Food chemistry		A23J%	
18	Food chemistry		A23K%	
18	Food chemistry		A23L%	
18	Food chemistry		C12C%	
18	Food chemistry		C12F%	
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18	Food chemistry		C12H%	
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18	Food chemistry		C13B 10%	August 15,
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18	Food chemistry		C13B 30%	August 15, 2011
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19	Basic materials chemistry	C10N%
19	Basic materials chemistry	C11B%
19	Basic materials chemistry	C11C%
19	Basic materials chemistry	C11D%
19	Basic materials chemistry	C99Z%
20	Materials, metallurgy	B22C%
20	Materials, metallurgy	B22D%
20	Materials, metallurgy	B22F%
20	Materials, metallurgy	C01B%
20	Materials, metallurgy	C01C%
20	Materials, metallurgy	C01D%
20	Materials, metallurgy	C01F%
20	Materials, metallurgy	C01G%
20	Materials, metallurgy	C03C%
20	Materials, metallurgy	C04B%
20	Materials, metallurgy	C21B%
20	Materials, metallurgy	C21C%
20	Materials, metallurgy	C21D%
20	Materials, metallurgy	C22B%
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20	Materials, metallurgy		C22F%	
21	Surface technology, coatin	g	B05C%	
21	Surface technology, coating		B05D%	
21	Surface technology, coating		B32B%	
21	Surface technology, coatin	a	C23C%	
21	Surface technology, coatin	-	C23D%	
21	Surface technology, coatin	•	C23F%	
21	Surface technology, coatin	-	C23G%	
21	Surface technology, coatin	-	C25B%	
21	Surface technology, coatin		C25C%	
21	Surface technology, coatin	•	C25D%	
21	Surface technology, coatin	-	C25F%	
21	Surface technology, coatin	g	C30B%	
22	Micro-structural and	nano-	B81B%	
	technology			
22	Micro-structural and	nano-	B81C%	
	technology			
22	Micro-structural and	nano-	B82B%	
	technology			
22	Micro-structural and	nano-	B82Y%	August 15,
	technology			2011
23	Chemical engineering		B01B%	
23	Chemical engineering		B01D 1%	
23	Chemical engineering		B01D 3%	
23	Chemical engineering		B01D 5%	
23	Chemical engineering		B01D 7%	
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23	Chemical engineering		B01D 61%	
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23	Chemical engineering	B01D 63%
23	Chemical engineering	B01D 65%
23	Chemical engineering	B01D 67%
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23	Chemical engineering	B01D 71%
23	u	B01F%
23	Chemical engineering	
	Chemical engineering	B01J%
23	Chemical engineering	B01L%
23	Chemical engineering	B02C%
23	Chemical engineering	B03B%
23	Chemical engineering	B03C%
23	Chemical engineering	B03D%
23	Chemical engineering	B04B%
23	Chemical engineering	B04C%
23	Chemical engineering	B05B%
23	Chemical engineering	B06B%
23	Chemical engineering	B07B%
23	Chemical engineering	B07C%
23	Chemical engineering	B08B%
23	Chemical engineering	C14C%
23	Chemical engineering	D06B%
23	Chemical engineering	D06C%
23	Chemical engineering	D06L%
23	Chemical engineering	F25J%
23	Chemical engineering	F26B%
23	Chemical engineering	H05H%
24	Environmental technology	A62C%
24	Environmental technology	B01D 45%
24	Environmental technology	B01D 46%
24	Environmental technology	B01D 47%
24	Environmental technology	B01D 49%
24	Environmental technology	B01D 50%
24	Environmental technology	B01D 51%
24	Environmental technology	B01D 52%
24	Environmental technology	B01D 53%
24	Environmental technology	B09B%
24	Environmental technology	B09C%
24	Environmental technology	B65F%
24	Environmental technology	C02F%
24	Environmental technology	E01F 8%
24	Environmental technology	F01N%
24	Environmental technology	F23G%
24	Environmental technology	F23J%
24	Environmental technology	G01T%
25	Handling	B25J%
25	Handling	B65B%
25	Handling	B65C%
25	Handling	B65D%
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05	Lieu - War	
25	Handling	B65G%
25	Handling	B65H%
25	Handling	B66B%
25	Handling	B66C%
25	Handling	B66D%
25	Handling	B66F%
25	Handling	B67B%
25	Handling	B67C%
25	Handling	B67D%
26	Machine tools	A62D%
26	Machine tools	B21B%
26	Machine tools	B21C%
26	Machine tools	B21D%
26	Machine tools	B21F%
26	Machine tools	B21G%
26	Machine tools	B21H%
26	Machine tools	B21J%
26	Machine tools	B21K%
26	Machine tools	B21L%
26	Machine tools	B23B%
26	Machine tools	B23C%
26	Machine tools	B23D%
26	Machine tools	B23F%
26	Machine tools	B23G%
26	Machine tools	B23H%
26	Machine tools	B23K%
26	Machine tools	B23P%
26	Machine tools	B23Q%
26	Machine tools	B24B%
26	Machine tools	B24C%
26	Machine tools	B24D%
26	Machine tools	B25B%
26	Machine tools	B25C%
26	Machine tools	B25D%
26	Machine tools	B25F%
26	Machine tools	B25G%
26	Machine tools	B25H%
26	Machine tools	B26B%
26	Machine tools	B26D%
26	Machine tools	B26F%
26	Machine tools	B27B%
26	Machine tools	B27C%
26	Machine tools	B27D%
26	Machine tools	B27F%
26	Machine tools	B27G%
26	Machine tools	B27H%
26	Machine tools	B27J%
26	Machine tools	B27K%
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26	Machine tools	B27L%
26	Machine tools	B27L% B27M%
26	Machine tools	B27N%
26	Machine tools	B30B%
20	Engines, pumps, turbines	F01B%
27	Engines, pumps, turbines	F01C%
27	Engines, pumps, turbines	F01D%
27	Engines, pumps, turbines	F01K%
27	Engines, pumps, turbines	F01L%
27	Engines, pumps, turbines	F01M%
27	Engines, pumps, turbines	F01P%
27	Engines, pumps, turbines	F02B%
27	Engines, pumps, turbines	F02C%
27	Engines, pumps, turbines	F02D%
27	Engines, pumps, turbines	F02F%
27	Engines, pumps, turbines	F02F %
27	Engines, pumps, turbines	F02G %
27	Engines, pumps, turbines	F02R%
27	Engines, pumps, turbines	F02M%
27	Engines, pumps, turbines	F02P%
27	Engines, pumps, turbines	F03B%
27	Engines, pumps, turbines	F03C%
27	Engines, pumps, turbines	F03D%
27	Engines, pumps, turbines	F03G%
27	Engines, pumps, turbines	F03H%
27	Engines, pumps, turbines	F03H%
27	Engines, pumps, turbines	F04D %
27	Engines, pumps, turbines	F04D%
27	Engines, pumps, turbines	F04F%
27	Engines, pumps, turbines	F23R%
27	Engines, pumps, turbines	F99Z%
27	Engines, pumps, turbines	G21B%
27	Engines, pumps, turbines	G21D%
27	Engines, pumps, turbines	G210%
27	Engines, pumps, turbines	G21D% G21F%
27	Engines, pumps, turbines	G21G%
27	Engines, pumps, turbines	G210% G21H%
27	Engines, pumps, turbines	G21J%
27	Engines, pumps, turbines	G215%
28	Textile and paper machines	A41H%
28	Textile and paper machines	A43D%
28	Textile and paper machines	A46D%
28	Textile and paper machines	B31B%
28	Textile and paper machines	B31C%
28	Textile and paper machines	B31D%
28	Textile and paper machines	B31E%
28	Textile and paper machines	B311 % B41B%
28	Textile and paper machines	B41C%
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28	Textile and paper machines	B41D%
28	Textile and paper machines	B41F%
28	Textile and paper machines	B41G%
28	Textile and paper machines	B41J%
28	Textile and paper machines	B41K%
28	Textile and paper machines	B41L%
28	Textile and paper machines	B41M%
28	Textile and paper machines	B41N%
28	Textile and paper machines	C14B%
28	Textile and paper machines	D01B%
28	Textile and paper machines	D01C%
28	Textile and paper machines	D01D%
28	Textile and paper machines	D01F%
28	Textile and paper machines	D01G%
28	Textile and paper machines	D01H%
28	Textile and paper machines	D02G%
28	Textile and paper machines	D02H%
28	Textile and paper machines	D02J%
28	Textile and paper machines	D03C%
28	Textile and paper machines	D03D%
28	Textile and paper machines	D03J%
28	Textile and paper machines	D04B%
28	Textile and paper machines	D04C%
28	Textile and paper machines	D04G%
28	Textile and paper machines	D04H%
28	Textile and paper machines	D05B%
28	Textile and paper machines	D05C%
28	Textile and paper machines	D06G%
28	Textile and paper machines	D06H%
28	Textile and paper machines	D06J%
28	Textile and paper machines	D060%
28	Textile and paper machines	D06P%
28	Textile and paper machines	D06Q%
28		D00Q % D21B%
	Textile and paper machines	D216%
28 28	Textile and paper machines	D210%
	Textile and paper machines	
28	Textile and paper machines	D21F%
28	Textile and paper machines	D21G%
28	Textile and paper machines	D21H%
28	Textile and paper machines	D21J%
28	Textile and paper machines	D99Z%
29	Other special machines	A01B%
29	Other special machines	A01C%
29	Other special machines	A01D%
29	Other special machines	A01F%
29	Other special machines	A01G%
29	Other special machines	A01J%
29	Other special machines	A01K%

29	Other special			A01L%	
29	Other special			A01M%	
29	Other special	machines		A21B%	
29	Other special	machines		A21C%	
29	Other special	machines		A22B%	
29	Other special	machines		A22C%	
29	Other special	machines		A23N%	
29	Other special			A23P%	
29	Other special			B02B%	
29	Other special			B28B%	
29	Other special			B28C%	
29	Other special			B28D%	
29	Other special			B29B%	
29	Other special			B29C%	
29	Other special			B29D%	
29	Other special			B29K%	
29	Other special			B29L%	
29	Other special			B33Y%	January 1,
29	Other special	machines		D331 /0	2015
29	Other special	machines		B99Z%	2013
29	Other special			C03B%	
29	Other special			C08J%	
29 29	Other special			C085 % C12L%	
					August 15
29	Other special	machines		C13B 5%	August 15,
29	Other enabled	maahinaa		C13B 15%	2011 August 15
29	Other special	machines		C13D 1576	August 15, 2011
29	Other special	machines		C13B 25%	August 15,
25	Other Special	machines		0100 2070	2011
29	Other special	machines		C13B 45%	August 15,
20		maoninioo		0102 1070	2011
29	Other special	machines		C13C%	2011
29	Other special			C13G%	
29	Other special			C13H%	
29	Other special			F41A%	
29	Other special			F41B%	
29	Other special			F41C%	
	Other special			F41F%	
29 20	•			F41F%	
29	Other special				
29	Other special			F41H%	
29	Other special			F41J%	
29	Other special			F42B%	
29	Other special			F42C%	
29	Other special	machines		F42D%	
30	Thermal	processes	and	F22B%	
	apparatus				
30	Thermal	processes	and	F22D%	
00	apparatus			F0000	
30	Thermal	processes	and	F22G%	

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30	Thermal	processes	and	F28F%
30	apparatus Thermal	processes	and	F28G%
04	apparatus			
31	Mechanical e			F15B%
31	Mechanical e			F15C%
31	Mechanical e			F15D%
31	Mechanical e			F16B%
31	Mechanical e			F16C%
31	Mechanical e			F16D%
31	Mechanical e			F16F%
31	Mechanical e			F16G%
31	Mechanical e			F16H%
31	Mechanical e			F16J%
31	Mechanical e	elements		F16K%
31	Mechanical e	elements		F16L%
31	Mechanical e	elements		F16M%
31	Mechanical e	elements		F16N%
31	Mechanical e	elements		F16P%
31	Mechanical e	elements		F16S%
31	Mechanical e	elements		F16T%
31	Mechanical e	elements		F17B%
31	Mechanical e	elements		F17C%
31	Mechanical e	elements		F17D%
31	Mechanical e	elements		G05G%
32	Transport			B60B%
32	Transport			B60C%
32	Transport			B60D%
32	Transport			B60F%
32	Transport			B60G%
32	Transport			B60H%
32	Transport			B60J%
32	Transport			B60K%
32	Transport			B60L%
32	Transport			B60M%
32	Transport			B60N%
32	Transport			B60P%
32	Transport			B60Q%
32	Transport			B60R%
32	Transport			B60S%
32	Transport			B60T%
				B60V%
32	Transport			B60V% B60W%
32	Transport			
32	Transport			B61B%
32	Transport			B61C%
32	Transport			B61D%
32	Transport			B61F%
32	Transport			B61G%

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32	Transport	B61H%
32	Transport	B61J%
32	Transport	B61K%
32	Transport	B61L%
32	Transport	B62B%
32	Transport	B62C%
32	Transport	B62D%
32	Transport	B62H%
32	Transport	B62J%
32	Transport	B62K%
32	Transport	B62L%
32	Transport	B62M%
32	Transport	B63B%
32	Transport	B63C%
32	Transport	B63G%
32	Transport	B63H%
32	Transport	B63J%
32	Transport	B64B%
32	Transport	B64C%
32	Transport	B64D%
32	Transport	B64F%
32	Transport	B64G%
33	Furniture, games	A47B%
33	Furniture, games	A47C%
33	Furniture, games	A47D%
33	Furniture, games	A47F%
33	Furniture, games	A47G%
33	Furniture, games	A47H%
33	Furniture, games	A47J%
33	Furniture, games	A47K%
33	Furniture, games	A47L%
33	Furniture, games	A63B%
33	Furniture, games	A63C%
33	Furniture, games	A63D%
33	Furniture, games	A63F%
33	Furniture, games	A63G%
33	Furniture, games	A63H%
33	Furniture, games	A63J%
33	Furniture, games	A63K%
34	Other consumer goods	A24B%
34	Other consumer goods	A24C%
34	Other consumer goods	A24D%
34	Other consumer goods	A24F%
34	Other consumer goods	A41B%
34	Other consumer goods	A41C%
34	Other consumer goods	A41D%
34	Other consumer goods	A41F%
34	Other consumer goods	A41G%
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34	Other consumer goods	A42B%
34	Other consumer goods	A42C%
34	Other consumer goods	A43B%
34	Other consumer goods	A43C%
34	Other consumer goods	A44B%
34	Other consumer goods	A44C%
34	Other consumer goods	A45B%
34	Other consumer goods	A45C%
34	Other consumer goods	A45D%
34	Other consumer goods	A45F%
34	Other consumer goods	A46B%
34	Other consumer goods	A62B%
34	Other consumer goods	A99Z%
34	Other consumer goods	B42B%
34	Other consumer goods	B42C%
34	Other consumer goods	B42D%
34	Other consumer goods	B42F%
34	Other consumer goods	B43K%
34	Other consumer goods	B43L%
34	Other consumer goods	B43M%
34	Other consumer goods	B44B%
34	Other consumer goods	B44C%
34	Other consumer goods	B44D%
34	Other consumer goods	B44F%
34	Other consumer goods	B68B%
34	Other consumer goods	B68C%
34	Other consumer goods	B68F%
34	Other consumer goods	B68G%
34	Other consumer goods	D04D%
34	Other consumer goods	D04D% D06F%
34	Other consumer goods	D06N%
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34 34	Other consumer goods	G10B%
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34	Other consumer goods	G10D%
34	Other consumer goods	G10F%
34	Other consumer goods	G10G%
34	Other consumer goods	G10H%
34	Other consumer goods	G10K%
35	Civil engineering	E01B%
35	Civil engineering	E01C%
35	Civil engineering	E01D%
35	Civil engineering	E01F 1%
35	Civil engineering	E01F 3%
35	Civil engineering	E01F 5%
35	Civil engineering	E01F 7%
35	Civil engineering	E01F 9%

35	Civil engineering	E01F 11%
35	Civil engineering	E01F 13%
35	Civil engineering	E01F 15%
35	Civil engineering	E01H%
35	Civil engineering	E02B%
35	Civil engineering	E02C%
35	Civil engineering	E02D%
35	Civil engineering	E02F%
35	Civil engineering	E03B%
35	Civil engineering	E03C%
35	Civil engineering	E03D%
35	Civil engineering	E03F%
35	Civil engineering	E04B%
35	Civil engineering	E04C%
35	Civil engineering	E04D%
35	Civil engineering	E04F%
35	Civil engineering	E04G%
35	Civil engineering	E04H%
35	Civil engineering	E05B%
35	Civil engineering	E05C%
35	Civil engineering	E05D%
35	Civil engineering	E05F%
35	Civil engineering	E05G%
35	Civil engineering	E06B%
35	Civil engineering	E06C%
35	Civil engineering	E21B%
35	Civil engineering	E21C%
35	Civil engineering	E21D%
35	Civil engineering	E21F%
35	Civil engineering	E99Z%

A.3 OECD concordance table

Technology area	Sub area	IPC codes
	Digital communication technique	H03K, H03L, H03M, H04B1/69- 1/719, H04J, H04L (excluding H04L9, H04L12/14) *H04L9, *H04L12/14
1. High speed network	Exchange, selecting	H04M3-13,19,99, H04Q
	Others	H04B1/00-1/68, H04B1/72- 1/76, H04B3-17 (excluding H04B1/59, H04B5, H04B7), H04H *H04B1/59, *H04B5, *H04B7
2. Mobile communication		H04B7, H04W (excluding H04W4/24, H04W12) *H04W4/24, *H04W12
3. Security	Cyphering, authentication	G06F12/14, G06F21, G06K19, G09C, G11C8/20, H04K, H04L9, H04M1/66-665, H04M1/667-675, H04M1/68- 70, H04M1/727, H04N7/167- 7/171, H04W12
	Electronic payment	G06Q20, G07F7/08-12, G07G1/12-1/14, H04L12/14, H04W4/24 *G06Q30/02
4. Sensor and device network	Sensor network	G08B1/08, G08B3/10, G08B5/22-38, G08B7/06, G08B13/18-13/196, G08B13/22-26, G08B25, G08B26, G08B27, G08C, G08G1/01-065 *G06F17/40, *H04W84/18
	Electronic tag	H04B1/59, H04B5 *G01S13/74-84, *G01V3, *G01V15
	Others	*H04W84/10
5. High speed computing		G06F5, G06F7, G06F9, G06F11, G06F13, G06F15/00, G06F15/16-15/177, G06F15/18, G06F 15/76-15/82

6. Large-capacity and high speed storage		G06F3/06–3/08, G06F12 (exclude G06F12/14), G06K1-7, G06K13, G11B, G11C(exclude G11C8/20), H04N5/78-5/907 *G06F12/14, *G11C8/20
7. Large-capacity information analysis	Database Data analysis, simulation, management	G06F17/30, G06F17/40 G06F17/00, G06F17/10-17/18, G06F17/50, G06F19, G06Q10, G06Q30, G06Q40,G06Q50, G06Q90, G06Q99, G08G (exclude G08G1/01-065, G08G1/0962-0969) *G08G1/01-065, *G08G1/0962-0969
8. Cognition and meaning understanding		G06F17/20-17/28, G06K9, G06T7, G10L13/027, G10L15, G10L17, G10L25/63,66 *G06F15/18
9. Human interface		H04M1 (exclude H04M1/66- 665, H04M1/667-675, H04M1/68-70, H04M1/727), G06F3/01-3/0489, G06F3/14- 3/153, G06F3/16, G06K11, G06T11/80, G08G1/0962- 0969, G09B5, G09B7, G09B9 *H04M1/66-665, *H04M1/667-675, *H04M1/68-70, *H04M1/727, *G06F17/50, *G06K9, *G06T11, *G06T13, *G06T15, *G06T17-19
10. Imaging and sound technology	Imaging technique	H04N (excluding H04N5/78- 5/907, H04N7/167-7/171), G06T1-9 (excluding G06T7), G06T11 (excluding G06T11/80), G06T13, G06T15, G06T17-19, G09G *H04N5/78-5/907, *H04N7/167-7/171, *G06T7, *G06T11/80
	Sound technique	H04R, H04S, G10L (excluding G10L13/027, G10L15, G10L17, G10L25/63,66) *G10L13/027,* G10L15, *G10L17, *G10L25/63,66
11. Information communication	Electronic circuit	НОЗВ, НОЗС, НОЗD, НОЗF, НОЗG, НОЗН, НОЗЈ
device	Cable and conductor	H01B11

	Semiconductor	H01L29-33, H01L21, 25, 27, 43- 51	
	Optic device	G02B6, G02F, H01S5	
	Others	B81B7/02, B82Y10, H01P, H01Q	
12. Electronic measurement		G01S, G01V3, G01V8, G01V15	
	Computer input- output	G06F3/00, G06F3/05, G06F3/09, G06F3/12, G06F3/13, G06F3/18	
13. Others	Other related technique	G06E, G06F1, G06F15/02, G06F15/04, G06F15/08-15/14, G06G7, G06J, G06K15, G06K17, G06N, H04M15, H04M17	

Legend: An asterisk (*) precedes those IPC codes that are relevant, although of secondary importance, for the technology area considered, and that may conversely be key in other ICT areas.

Technology area	Sub area	IPC
11. Information communication device	Others	B81B7/02
11. Information communication device	Others	B82Y10
12. Electronic measurement		GO1S
12. Electronic measurement		G01V15
12. Electronic measurement		G01V3
12. Electronic measurement		G01V8
11. Information communication device	Optic device	G02B6
11. Information communication device	Optic device	G02F
13. Others	Other related technique	G06E
5. High speed computing		G06F 15/16- 15/177
5. High speed computing		G06F 15/76-15/82
13. Others	Other related technique	G06F1
5. High speed computing		G06F11
6. Large-capacity and high speed storage		G06F12 (exclude G06F12/14)
3. Security	Cyphering, authentication	G06F12/14
5. High speed computing		G06F13
5. High speed computing		G06F15/00
13. Others	Other related technique	G06F15/02
13. Others	Other related technique	G06F15/04
13. Others	Other related technique	G06F15/08-15/14
5. High speed computing		G06F15/18
7. Large-capacity information analysis	Data analysis, simulation, management	G06F17/00
7. Large-capacity information analysis	Data analysis, simulation, management	G06F17/10-17/18
8. Cognition and meaning understanding		G06F17/20-17/28
7. Large-capacity information analysis	Database	G06F17/30
7. Large-capacity information analysis	Database	G06F17/40
7. Large-capacity information analysis	Data analysis, simulation, management	G06F17/50
7. Large-capacity information analysis	Data analysis,	G06F19

	cimulation	
	simulation, management	
3. Security	Cyphering,	G06F21
5. Security	authentication	000121
13. Others	Computer input-	G06F3/00
	output	
9. Human-interface		G06F3/01-3/0489
13. Others	Computer input-	G06F3/05
	output	
6. Large-capacity and high speed		G06F3/06-3/08
storage 13. Others	Computer input-	G06F3/09
15. Others	output	G00F3/09
13. Others	Computer input-	G06F3/12
	output	000.0, ==
13. Others	Computer input-	G06F3/13
	output	
9. Human-interface		G06F3/14-3/153
9. Human-interface		G06F3/16
13. Others	Computer input-	G06F3/18
	output	00055
5. High speed computing		G06F5
5. High speed computing		G06F7
5. High speed computing		G06F9
13. Others	Other related	G06G7
	technique	
13. Others	Other related technique	G06J
9. Human-interface	teeninque	G06K11
6. Large-capacity and high speed		G06K13
storage		
6. Large-capacity and high speed		G06K13
storage	Other related	C0Cl//1F
13. Others	Other related technique	G06K15
13. Others	Other related	G06K17
	technique	
6. Large-capacity and high speed		G06K1-7
storage 3. Security	Cyphering,	G06K19
3. Security	authentication	GUOKI9
8. Cognition and meaning		G06K9
understanding		
13. Others	Other related	G06N
	technique	
7. Large-capacity information analysis	Data analysis,	G06Q10
	simulation,	
2 Security	management	
3. Security	Electronic	G06Q20

	payment	
7. Large-capacity information analysis	Data analysis, simulation,	G06Q30
	management	
7. Large-capacity information analysis	Data analysis, simulation,	G06Q40
7. Large-capacity information analysis	management Data analysis,	G06Q50
	simulation, management	600030
7. Large-capacity information analysis	Data analysis, simulation, management	G06Q90
7. Large-capacity information analysis	Data analysis, simulation, management	G06Q99
10. Imaging and sound technology	Imaging	G06T11 (exclude
9. Human-interface	technique	G06T11/80) G06T11/80
		•
10. Imaging and sound technology	Imaging technique	G06T13
10. Imaging and sound technology	Imaging technique	G06T15 3D
10. Imaging and sound technology	Imaging technique	G06T17-19
10. Imaging and sound technology	Imaging technique	G06T1-9 (exclude G06T7)
8. Cognition and meaning understanding		G06T7
3. Security	Electronic payment	G07F7/08-12
3. Security	Electronic payment	G07G1/12-1/14
4. Sensor and device network	Sensor network	G08B1/08
4. Sensor and device network	Sensor network	G08B13/18-13/196
4. Sensor and device network	Sensor network	G08B13/22-26
4. Sensor and device network	Sensor network	G08B25
4. Sensor and device network	Sensor network	G08B26
4. Sensor and device network	Sensor network	G08B27
4. Sensor and device network	Sensor network	G08B3/10
4. Sensor and device network	Sensor network	G08B5/22-38
4. Sensor and device network	Sensor network	G08B7/06
4. Sensor and device network	Sensor network	G08C
7. Large-capacity information analysis	Data analysis, simulation, management	G08G (exclude G08G1/01- 065,G08G1/0962- 0969)
4. Sensor and device network	Sensor network	G08G1/01-065

9. Human-interface		G08G1/0962-0969
9. Human-interface		G09B5
9. Human-interface		G09B7
9. Human-interface		G09B9
	Cuphoring	G09C
3. Security	Cyphering, authentication	G09C
10. Imaging and sound technology	Imaging	G09G
	technique	
10. Imaging and sound technology	Sound technique	G10L (exclude
		G10L13/027, G10L15, G10L17,
		G10L15, G10L17, G10L17, G10L25/63,66)
8. Cognition and meaning		G10L13/027
understanding		010110,017
8. Cognition and meaning		G10L15
understanding		
8. Cognition and meaning		G10L17
understanding		
8. Cognition and meaning		G10L25/63,66
understanding		G11C (exclude
6. Large-capacity and high speed storage		G11C (exclude G11C8/20)
3. Security	Cyphering,	G11C8/20
5. Security	authentication	01100/20
11. Information communication	Cable and	H01B11
device	conductor	
11. Information communication	Semiconductor	H01L21, 25, 27, 43-
device		51
11. Information communication	Semiconductor	H01L29-33
device 11. Information communication	Othors	1010
11. Information communication device	Others	H01P
11. Information communication	Others	H01Q
device		
11. Information communication	Optic device	H01S5
device		
11. Information communication	Electronic circuit	H03B
device		
11. Information communication	Electronic circuit	H03C
device 11. Information communication	Electronic circuit	H03D
device		1050
11. Information communication	Electronic circuit	H03F
device		
11. Information communication	Electronic circuit	H03G
device		
11. Information communication	Electronic circuit	H03H
device		11021
11. Information communication	Electronic circuit	НОЗЈ
device		

Image speed networkDigital communication techniqueHost communication technique1. High speed networkDigital communication techniqueHO3L1. High speed networkDigital communication techniqueHO4B1/00-1/68, HO4B3/72-1/76, HO4B5, HO4B5, HO4B5, HO4B7)1. High speed networkOthersHO4B1/02-1/76, HO4B5, HO4B5, HO4B7)4. Sensor and device networkElectronic tagHO4B1/59-1. High speed networkDigital communication techniqueHO4B5, HO4B5,2. Mobile communication techniqueHO4B53. SecurityCyphering, authenticationHO4K1. High speed networkDigital communication techniqueHO4H1. High speed networkDigital communication techniqueHO4H3. SecurityCyphering, authenticationHO4L2/143. SecurityElectronic paymentHO4L12/143. SecurityCyphering, authenticationHO4M1 (exclude HO4M1/66-665, HO4M1/66-	1. High speed network	Digital	НОЗК
techniqueH03L1. High speed networkDigital communication techniqueH03L1. High speed networkDigital communication techniqueH03M1. High speed networkOthersH04B1/00-1/68, H04B1/72-1/76, H04B3/17 (exclude 1/59, H04B3)4. Sensor and device networkElectronic tagH04B1/591. High speed networkDigital communication techniqueH04B1/591. High speed networkElectronic tagH04B1/69-1/7192. Mobile communication techniqueH04B5H04B71. High speed networkDigital communication techniqueH04B71. High speed networkDigital communication techniqueH04B71. High speed networkDigital communication techniqueH04L H04L3. SecurityDigital communication techniqueH04L (exclude H04L)3. SecurityElectronic paymentH04L H04L12/143. SecurityCyphering, authenticationH04L12/149. Human-interfaceLogy phering, authenticationH04M1/66-665 H04M1/66-665 H04M1/66-7675 H04M1/66-7675 H04M1/66-7675 H04M1/66-765 H04M1/66-7657 H04M1/66-765H04M1/66-7653. SecurityCyphering, authenticationH04M1/66-7675 H04M1/66-7675 H04M1/66-7675 H04M1/66-7675H04M1/66-7675 H04M1/66-765 H04M1/66-765 H04M1/66-7653. SecurityCyphering, authenticationH04M1/66-7675 H04M1/66-7675 H04M1/66-765 H04M1/66-765H04M1/66-765 H04M1/66-7653. SecurityCyphering, authenticationH0	1. High speed network	-	HUSK
1. High speed networkDigital communication techniqueH03L1. High speed networkDigital communication techniqueH03M1. High speed networkOthersH04B1/02-1/68, H04B3-17 (exclude 1/59, H04B5, H04B7]4. Sensor and device networkElectronic tagH04B1/591. High speed networkDigital communication techniqueH04B1/594. Sensor and device networkElectronic tagH04B1/69-1/7194. Sensor and device networkElectronic tagH04B52. Mobile communication techniqueH04B7H04B71. High speed networkOthersH04B71. High speed networkDigital communication techniqueH04L3. SecurityCyphering, authenticationH04L (exclude communication technique3. SecurityElectronic paymentH04L12/143. SecurityElectronic paymentH04L12/143. SecurityCyphering, authenticationH04L12/143. SecurityCyphering, authenticationH04M1 (exclude H04M1/66-665, H04M1/66-665, H04M1/66-655,<			
Communication techniqueHoad Hoad1. High speed networkDigital communication techniqueHO4B1/00-1/68, HO4B1/72-1/76, HO4B3-17 (exclude 1/59, HO4B5, HO4B7)4. Sensor and device networkElectronic tagHO4B1/591. High speed networkDigital communication techniqueHO4B1/591. High speed networkElectronic tagHO4B1/69-1/7194. Sensor and device networkElectronic tagHO4B1/69-1/7192. Mobile communication techniqueHO4B7HO4B71. High speed networkOthersHO4B71. High speed networkDigital communication techniqueHO4B71. High speed networkDigital communication techniqueHO4B73. SecurityCyphering, authenticationHO4L (exclude technique3. SecurityDigital communication techniqueHO4L (exclude HO4L12/14)3. SecurityCyphering, authenticationHO4L12/143. SecurityCyphering, authenticationHO4L12/143. SecurityCyphering, authenticationHO4M1 (exclude HO4M1/667-675, HO4M1/6	1. High speed network		H03L
techniquetechniqueH03M1. High speed networkDigital communication techniqueH04B1/00-1/68, H04B1/72-1/76, H04B3.17 (exclude 1/59, H04B3.17 (exclude 1/59, H04B7)4. Sensor and device networkElectronic tagH04B1/591. High speed networkElectronic tagH04B1/109-1/719 comunication technique4. Sensor and device networkElectronic tagH04B1/591. High speed networkElectronic tagH04B52. Mobile communication techniqueH04B71. High speed networkOthersH04H3. SecurityCyphering, authentication techniqueH04L3. SecurityDigital communication techniqueH04L (exclude H04L12/14)3. SecurityCyphering, authenticationH04L (exclude H04L9,H04L12/14)3. SecurityCyphering, authenticationH04L12/14 H04L12/14)3. SecurityCyphering, authenticationH04L1 (exclude H04M1/667-675, H04M1/667-66		0	
1. High speed networkDigital communication techniqueH03M1. High speed networkOthersH04B1/00-1/68, H04B3/72-1/76, H04B3/72-1/76, H04B3/74. Sensor and device networkElectronic tagH04B1/591. High speed networkDigital communication techniqueH04B1/591. High speed networkDigital communication techniqueH04B1/69-1/7192. Mobile communication 1. High speed networkDigital communication techniqueH04B53. SecurityOthersH04H1. High speed networkDigital communication techniqueH04H1. High speed networkDigital communication techniqueH04H3. SecurityCyphering, authenticationH04L (exclude H04L9/H04L12/14)3. SecurityElectronic paymentH04L12/14 payment3. SecurityCyphering, authentication authenticationH04M1 (exclude H04M1/667-675, 			
communication techniqueHo481/00-1/68, H0481/72-1/76, H0483-17 (exclude 1/59, H0485)1. High speed networkOthersH0481/594. Sensor and device networkElectronic tagH0481/591. High speed networkDigital communication techniqueH04852. Mobile communication 1. High speed networkElectronic tagH04853. SecurityOthersH04871. High speed networkDigital communication techniqueH04853. SecurityCyphering, authenticationH04873. SecurityElectronic tagH04L (exclude technique3. SecurityCyphering, authenticationH04L (exclude H04L12/14) payment3. SecurityCyphering, authenticationH04M1 (exclude H04L12/14 payment9. Human-interfaceCyphering, authenticationH04M1/667-675, <b< td=""><td>1. High speed network</td><td></td><td>H03M</td></b<>	1. High speed network		H03M
1. High speed networkOthersH04B1/02-1/68, H04B1/72-1/76, H04B3-17 (exclude 1/59, H04B5, H04B7)4. Sensor and device networkElectronic tagH04B1/591. High speed networkDigital communication techniqueH04B1/69-1/7194. Sensor and device networkElectronic tagH04B52. Mobile communicationH04B711. High speed networkOthersH04H1. High speed networkDigital communication techniqueH04H3. SecurityCyphering, authenticationH04L1. High speed networkDigital communication techniqueH04L1. High speed networkDigital communication techniqueH04L3. SecurityCyphering, authenticationH04L12/143. SecurityCyphering, authenticationH04M1/66-665, H04M1/66-665, H04M1/66-665, H04M1/66-665, H04M1/66-665, H04M1/66-6653. SecurityCyphering, authenticationH04M1/66-665 H04M1/66-6653. SecurityCyphering, authenticationH04M1/66-665 H04M1/66-6653. SecurityCyphering, authenticationH04M1/66-665 H04M1/66-6653. SecurityCyphering, authenticationH04M1/66-665 H04M1/66-6653. SecurityCyphering, authenticationH04M1/68-70 H04M1/66-6653. SecurityCyphering, authenticationH04M1/68-70 H04M1/68-703. SecurityCyphering, authenticationH04M1/68-70 H04M1/68-703. SecurityCyphering, authenticationH04M1/68-70 H04M1/68-70<	5	0	
A. Sensor and device networkElectronic tagH04B1/72-1/76, H04B3-17 (exclude 1/59, H04B5, H04B7)4. Sensor and device networkElectronic tagH04B1/69-1/719 communication techniqueH04B1/69-1/719 communication technique4. Sensor and device networkElectronic tagH04B14. Sensor and device networkElectronic tagH04B52. Mobile communicationH04B5H04B71. High speed networkOthersH04H1. High speed networkDigital communication techniqueH04H3. SecurityCyphering, authenticationH04L13. SecurityElectronic paymentH04L12/14 Payment3. SecurityCyphering, authenticationH04M1 (exclude H04M1/66-665, H04M1/66-665, H04M1/66-665, H04M1/66-6757, H04M1/66-6757, H04M1/66-6757		technique	
HouseHouseHouseHouse4. Sensor and device networkElectronic tagHouse1. High speed networkDigital communication techniqueHouse4. Sensor and device networkElectronic tagHouse4. Sensor and device networkElectronic tagHouse3. SecurityOthersHouse1. High speed networkDigital communication techniqueHouse3. SecurityCyphering, authenticationHouse3. SecurityDigital communication techniqueHouse3. SecurityCyphering, authenticationHouse3. SecurityCyphering, authenticationHouse<	1. High speed network	Others	H04B1/00-1/68,
1/59, H04B5, H04B74. Sensor and device networkElectronic tagH04B1/591. High speed networkDigital communication techniqueH04B52. Mobile communicationElectronic tagH04B51. High speed networkOthersH04B71. High speed networkDigital communication techniqueH04B71. High speed networkOthersH04H1. High speed networkOthersH04H3. SecurityCyphering, authenticationH04L3. SecurityElectronic tagH04L (exclude H04L9,H04L12/14)3. SecurityElectronic paymentH04L93. SecurityCyphering, authenticationH04L99. Human-interfaceCyphering, authenticationH04M1 (exclude H04M1/66-665, H04M1/66-665, H04M1/67-675, H04M1/68-703. SecurityCyphe			H04B1/72-1/76,
Image: space s			H04B3-17 (exclude
4. Sensor and device networkElectronic tagH04B1/591. High speed networkDigital communication techniqueH04B1/69-1/7194. Sensor and device networkElectronic tagH04B52. Mobile communicationH04B7H04B71. High speed networkOthersH04H1. High speed networkDigital communication techniqueH04H3. SecurityCyphering, authenticationH04K3. SecurityDigital communication techniqueH04L (exclude technique3. SecurityElectronic paymentH04L12/143. SecurityCyphering, authenticationH04M1 (exclude H04M1/66-65, H04M1/66-65, H04M1/66-75, H04M1/66-765, H04M1/68-70 authenticationH04M1/66-765, H04M1/66-765, H04M1/66-765, H04M1/66-765, H04M1/68-70 authentication3. SecurityCyphering, authenticationH04M1/66-765, H04M1/68-703. SecurityCyphering, authenticationH04M1/727 H04M1/68-703. SecurityCyphering, authenticationH04M1/727 H04M1/7273. OthersOther related techniqueH04M1/72713. OthersOther related techniqu			1/59, H04B5,
1. High speed networkDigital communication techniqueH04B1/69-1/7194. Sensor and device networkElectronic tagH04B52. Mobile communicationH04B7H04B71. High speed networkOthersH04H1. High speed networkDigital communication techniqueH04J3. SecurityCyphering, authenticationH04L1. High speed networkDigital communication techniqueH04K3. SecurityCyphering, authenticationH04L (exclude H04L12/14) recommunication technique3. SecurityElectronic paymentH04L12/143. SecurityCyphering, authenticationH04M1 (exclude H04M1/66-665, H04M1/66-665, H04M1/66-665, H04M1/66-665, H04M1/66-6659. Human-interfaceCyphering, authenticationH04M1/66-665 H04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-7033. SecurityCyphering, authenticationH04M1/68-703. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authentication<			H04B7)
communication techniqueCommunication technique4. Sensor and device networkElectronic tagH04B52. Mobile communicationOthersH04H1. High speed networkDigital communication techniqueH04J1. High speed networkDigital communication techniqueH04K3. SecurityCyphering, authentication techniqueH04L1. High speed networkDigital communication techniqueH04L3. SecurityElectronic paymentH04L9,H04L12/14)3. SecurityElectronic paymentH04L93. SecurityCyphering, authenticationH04M1 (exclude H04M1 (exclude H04M1/66-665,<	4. Sensor and device network	Electronic tag	H04B1/59
technique4. Sensor and device networkElectronic tagH04B52. Mobile communicationH04B71. High speed networkOthersH04H1. High speed networkDigital communication techniqueH04J3. SecurityCyphering, authenticationH04K1. High speed networkDigital communication techniqueH04K3. SecurityCyphering, authenticationH04K3. SecurityElectronic paymentH04L12/143. SecurityElectronic paymentH04L12/149. Human-interfaceKophering, authenticationH04M1 (exclude H04M1/66-665, H04M1/66-665, H04M1/66-665, H04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-76753. SecurityCyphering, authenticationH04M1/66-76753. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/727 <td>1. High speed network</td> <td>Digital</td> <td>H04B1/69-1/719</td>	1. High speed network	Digital	H04B1/69-1/719
4. Sensor and device networkElectronic tagH04B52. Mobile communicationH04B7H04H1. High speed networkOthersH04H1. High speed networkDigital communication techniqueH04J3. SecurityCyphering, authenticationH04K1. High speed networkDigital communication techniqueH04L3. SecurityCyphering, authenticationH04L3. SecurityElectronic paymentH04L12/143. SecurityElectronic paymentH04L99. Human-interfaceH04M1 (exclude H04M1/667-675, H04M1/667-675, H04M1/667-675H04M1/667-6753. SecurityCyphering, authenticationH04M1/667-6753. SecurityCyphering, authenticationH04M1/667-6753. SecurityCyphering, authenticationH04M1/667-6753. SecurityCyphering, authenticationH04M1/667-6753. SecurityCyphering, authenticationH04M1/667-6753. SecurityCyphering, authenticationH04M1/667-6753. SecurityCyphering, authenticationH04M1/667-6753. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering,		communication	
2. Mobile communicationHO4B71. High speed networkOthersH04H1. High speed networkDigital communication techniqueH04J3. SecurityCyphering, authenticationH04K1. High speed networkDigital communication techniqueH04L1. High speed networkDigital communication techniqueH04L3. SecurityCyphering, authenticationH04L12/14)3. SecurityElectronic paymentH04L12/143. SecurityCyphering, authenticationH04L99. Human-interfaceKophering, authenticationH04M1 (exclude H04M1/66-665, H04M1/66-665, H04M1/66-665, H04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/72713. OthersOther related techniqueH04M1/72713. OthersOther related techniqueH04M1713. OthersOther related techniqueH04M17		technique	
1. High speed networkOthersH04H1. High speed networkDigital communication techniqueH04J3. SecurityCyphering, authenticationH04K1. High speed networkDigital communication techniqueH04L (exclude H04L9,H04L12/14)1. High speed networkDigital communication techniqueH04L (exclude H04L9,H04L12/14)3. SecurityElectronic paymentH04L123. SecurityCyphering, authenticationH04L199. Human-interfaceH04M1 (exclude H04M1/66-665, H04M1/66-665, H04M1/66-665, H04M1/66-665H04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/66-6653. SecurityCyphering, authenticationH04M1/67-6753. SecurityCyphering, authenticationH04M1/67-6753. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. SecurityCyphering, authenticationH04M1/7273. S	4. Sensor and device network	Electronic tag	H04B5
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technique	13. Others		H04M17
1. High speed networkExchange,H04M3-13,19,99			
	1. High speed network	Exchange,	H04M3-13,19,99

	selecting	
10. Imaging and sound technology	Imaging technique	H04N (exclude H04N5/78-5/907, H04N7/167-7/171)
6. Large-capacity and high speed storage		H04N5/78-5/907
3. Security	Cyphering, authentication	H04N7/167-7/171
1. High speed network	Exchange, selecting	H04Q
10. Imaging and sound technology	Sound technique	H04R
10. Imaging and sound technology	Sound technique	H04S
2. Mobile communication		H04W (exclude H04W4/24, W12)
3. Security	Cyphering, authentication	H04W12
3. Security	Electronic payment	H04W4/24

Legend: An asterisk precedes those IPC codes that are relevant, although of secondary importance, for the technology area

Technology area	Sub area	IPC
4. Sensor and device network	Electronic tag	*G01S13/74-84
4. Sensor and device network	Electronic tag	*G01V15
4. Sensor and device network	Electronic tag	*G01V3
6. Large-capacity and high speed storage		*G06F12/14
8. Cognition and meaning understanding		*G06F15/18
4. Sensor and device network	Sensor network	*G06F17/40
9. Human-interface		*G06F17/50
9. Human-interface		*G06K9
9. Human-interface		*G06T11
10. Imaging and sound technology	Imaging technique	*G06T11/80
9. Human-interface		*G06T13
9. Human-interface		*G06T15
9. Human-interface		*G06T17-19
10. Imaging and sound technology	Imaging technique	*G06T7
7. Large-capacity information analysis	Data analysis, simulation, management	*G08G1/01-065, G08G1/0962-0969
10. Imaging and sound technology	Sound technique	*G10L13/027, G10L15, G10L17, G10L25/63,66
6. Large-capacity and high speed		*G11C8/20,

storage		G11C16/22
1. High speed network	Others	*H04B1/59 <i>,</i> H04B5, H04B7
1. High speed network	Digital communication technique	*H04L9, H04L12/14
9. Human-interface		*H04M1/66-665, H04M1/667-675, H04M1/68-70, H04M1/727
10. Imaging and sound technology	Imaging technique	*H04N5/78-5/907, H04N7/167
2. Mobile communication		*H04W4/24, H04W12
4. Sensor and device network	Others	*H04W84/10
4. Sensor and device network	Sensor network	*H04W84/18

A.4 OECD source 2

Technical			
field to be identified	code	detail	
Identined	coue	uetan	
IoT	IPC	10 codes (G05B019/418, G06F015/16, G08C017/02, H04B007/26, H04L012/28, H04L029/06, H04L029/08, H04W004/00, H04W072/04, H04W084/18,)	https://www.sciencedirect.com/science/article/pi i/S0040162517305498
M2M/IoT	CPC	1 code	
Robotics and Autonomou s Systems	IPC	(H04W4/005) CPC: B25J9/16* B25J9/0003 B25J11/0005 B25J11/0015 B60W30/00* Y10S901/00* G05D1/0088 G05D1/02* G05D2201/0207 G05D2201/0212 ICP: B25J9/16* B60W30/00* G05D1/02*	UK IP Office, 2014. Robotics and Autonomous Systems: A patent overview, UK Intellectual Property (IP) Office Available at. https://www.gov.uk/government/uploads/system /uploads/attachment_data/file/318236/Robotics _Autonomous.pdf
AI	IPC, UPC	38 codes for IPC (G06E1/00, G06E3/00, G06F15/00, G06F15/18, G06F17/20, G06G7/00, G06B13/02, G06E1/00, G06E1/00, G06E3/00, G06F15/18, G06G7/00, G06N3/00, G06N3/08, G06N3/02, G06N3/12,	http://www.tandfonline.com/doi/pdf/10.5172/imp p.2013.15.4.463?needAccess=true

AI IPC G06N from my memo in meeting of last December(Not published) AI IPC IPC codes: G06N 3/00 G06N 3/02 G06N 3/04 Fujii, H., & Managi, S. (2018). Trends and priority shifts in artificial intelligence technology invention: A global patent analysis. Economic Analysis and Policy G06N 3/06 G06N 3/06 G06N 3/06 G06N 3/06 G06N 3/06 G06N 3/06 G06N 3/08 G06N 3/10 G06N 5/00 G06N 5/00 G06N 5/00 G06N 7/00 G06N 7/00 G06N 7/00 G06N 7/00 G06N 7/00 G06N 7/00 G06N 7/00 G06N 7/00 G06N 7/00			G06E1/00, G06E3/00, G06F15/00, G06F15/18, G06F17/00, G06N3/00, G06N3/00, G06N3/04, G06N3/10, G06F15/00, G06F15/18, G06F15/18, G06F17/00, G06F9/44, G06N5/02, G06N5/02, G06N5/04, G06N7/00, G06N7/02, G06N7/04, G06N7/04, G06N7/06, G06N7/08) 62 codes for UPC (706 1-62)	
AIIPCIPCcodes: G06NFujii, H., & Managi, S. (2018). Trends and priority shifts in artificial intelligence technology invention: A global patent analysis. Economic AnalysisG06N3/04G06N3/04G06N3/06G06N3/06G06N3/063G06N3/067G06N3/067G06N3/08G06N3/067G06N3/08G06N3/067G06N3/07G06N3/067G06N3/08G06N3/067G06N3/08G06N3/067G06N3/02G06N5/00G06N5/02G06N5/02G06NG06N7/02G06NG06N7/04G06NG06N7/06G06NG06N7/08	AI	IPC	· · · /	
	AI	IPC	G06N 3/00 G06N 3/02 G06N 3/04 G06N 3/06 G06N 3/063 G06N 3/067 G06N 3/067 G06N 3/08 G06N 3/10 G06N 3/12 G06N 5/00 G06N 5/02 G06N 5/04 G06N 7/00 G06N 7/02 G06N 7/04 G06N 7/06 G06N 7/08	Fujii, H., & Managi, S. (2018). Trends and priority shifts in artificial intelligence technology invention: A global patent analysis. Economic Analysis and Policy https://www.sciencedirect.com/science/article/pi

Appendix B – Linking **PATSTAT** to the Web of Science

To link and match the PATSTAT database to the Web of Science (WoS) database, we use non-disclosed propriety software developed at CWTS10. We identify scientific literature cited in patents by parsing character strings in bibliographic records of those patents. The 'non patent literature' (NPL) patent-to-publication citations are stored as text strings containing bibliographic information. These reference strings have no fixed format or prescribed structure and therefore in general a parsing algorithm is needed to extract relevant information. The text strings describing a reference to a NPL document are parsed to find information that identifies a publication.

If a DOI string is found it is matched with the DOIs in the WoS database to find the bibliographic information. When no matching DOI can be found the NPL reference strings are parsed in order to find identifying information such as publication year, journal volume number, issue number, beginning page, ending page, author(s) and title. Combinations of the identifying information is used and matched with the information in the WoS. If enough identifying information elements can be matched to accurately identify a publication in the WoS the NPL-reference is considered to match the information in the WoS for a specific publication.

More specifically, the information in field NPL_PBIBLIO in PATSTAT's table TLS214 and also use the information provided by the EPO in the latest versions of PATSTAT - the EPO also parses the information. From the parsed information items provided by the EPO and the results of our own parsing software, we extract as much identifying information (DOI, Volume, Issue, Publication year, pages, author(s), title, journal) as possible. With the exception of the DOI's - as they should identify a document by definition - we match as many items as possible with our in-house version of the Web of Science database as possible to find matches. Having established 'citing-cited' matches between citing patents and cited research publications, this results in a table that contains pairs of PATSTAT's NPL_PUBLN_ID's and WOS UT. This table contains low-level information.

The data collection is done on the DOCDB_FAMILY level, by combining the information from our 'link table' with information from other tables in PATSTAT. The DOCDB_FAMILY level is used as the documents that make up such a patent family are equivalent in legal sense. Our computational analysis is based on patent families, rather than individual patents, where highly related patents filed in different patent systems, occur. The 2017 autumn version of PATSTAT is used. It is important to use the same version of PATSTAT as the IDs in TBL214 are in general unstable between different version of PATSTAT and for each version of everything needs to be recalculated.

¹⁰ The search algorithms and subsequent automated data-cleaning and parsing routines, to extract unique cited scientific references, are obtained by a multi-stage procedure. Duplicate references are identified and standardized. Zhao et al. (2016) and Caron (2017) present examples of such a computerized approach. Our methodology differs in the sense that also includes pre-parsed information provided by the EPO.

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Understanding how progress in science is connected to technological development is crucial to get a better handle of the drivers and policy levers that can foster science-based innovation in a rapidly changing innovation ecosystems and knowledgeintensive economies.

One area of rising interest is understanding in more detail the role of basic and applied scientific research in driving new emerging technologies and related technological innovations. Science is an important source of novel ideas, tools, materials and prototypes in some areas of advanced technological development. The key question however is whether or not science has become increasingly important in recent technological developments. To address this question, in a broad systematic fashion, one needs to establish a stable frame of reference, appropriate empirical information, and a sufficiently long time-window.

Studies and reports

